

Potential induced degradation and light induced degradation in c-Si solar cells

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Outline

- IV measurement of solar cells
- Potential induced degradation (PID)
 - What is it?
 - Basic mechanism
 - Recovery
 - Mitigation strategies
 - PID test standard
- Light induced degradation (LID)
 - What is it?
 - Basic mechanism
 - Mitigation strategies

IV measurement of solar cells

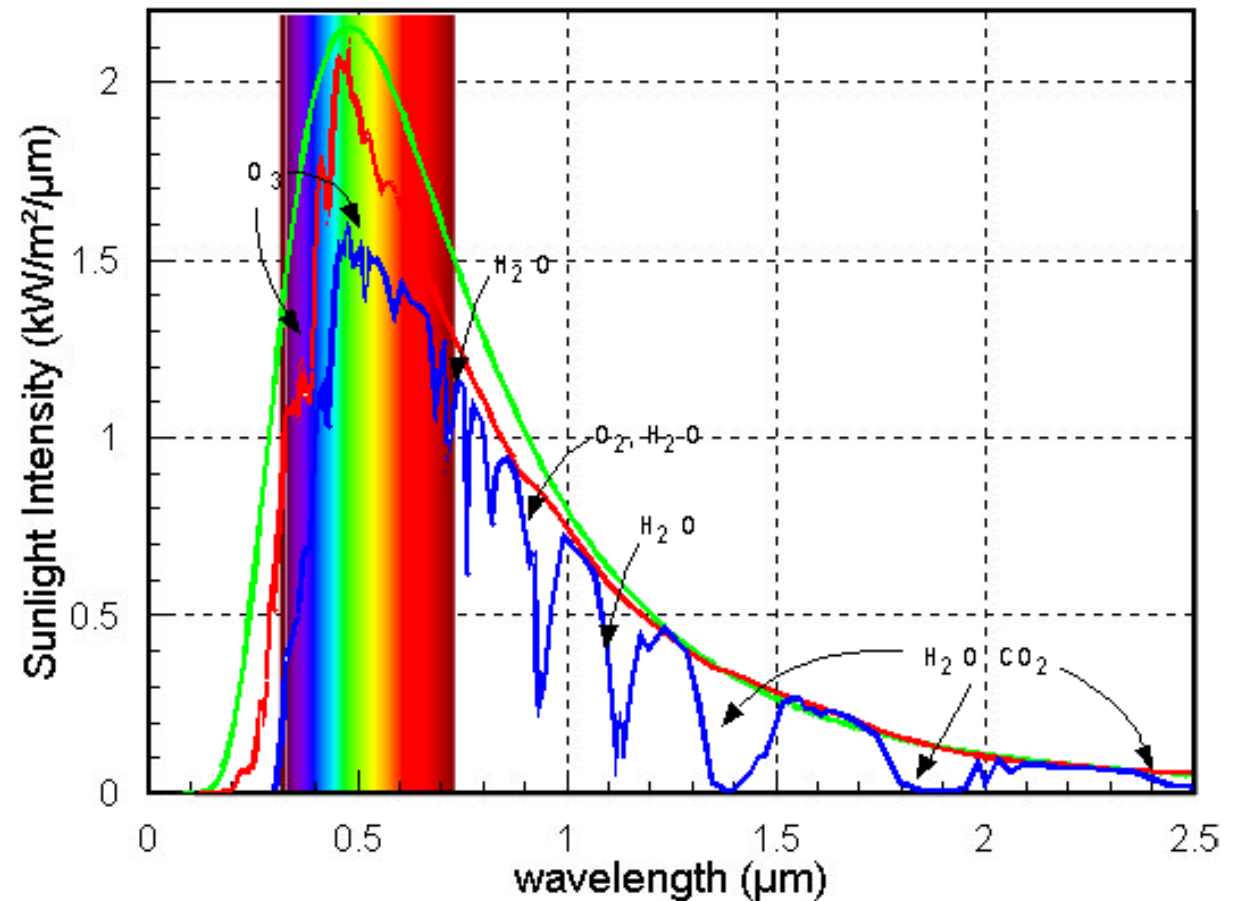


STC:

AM1.5

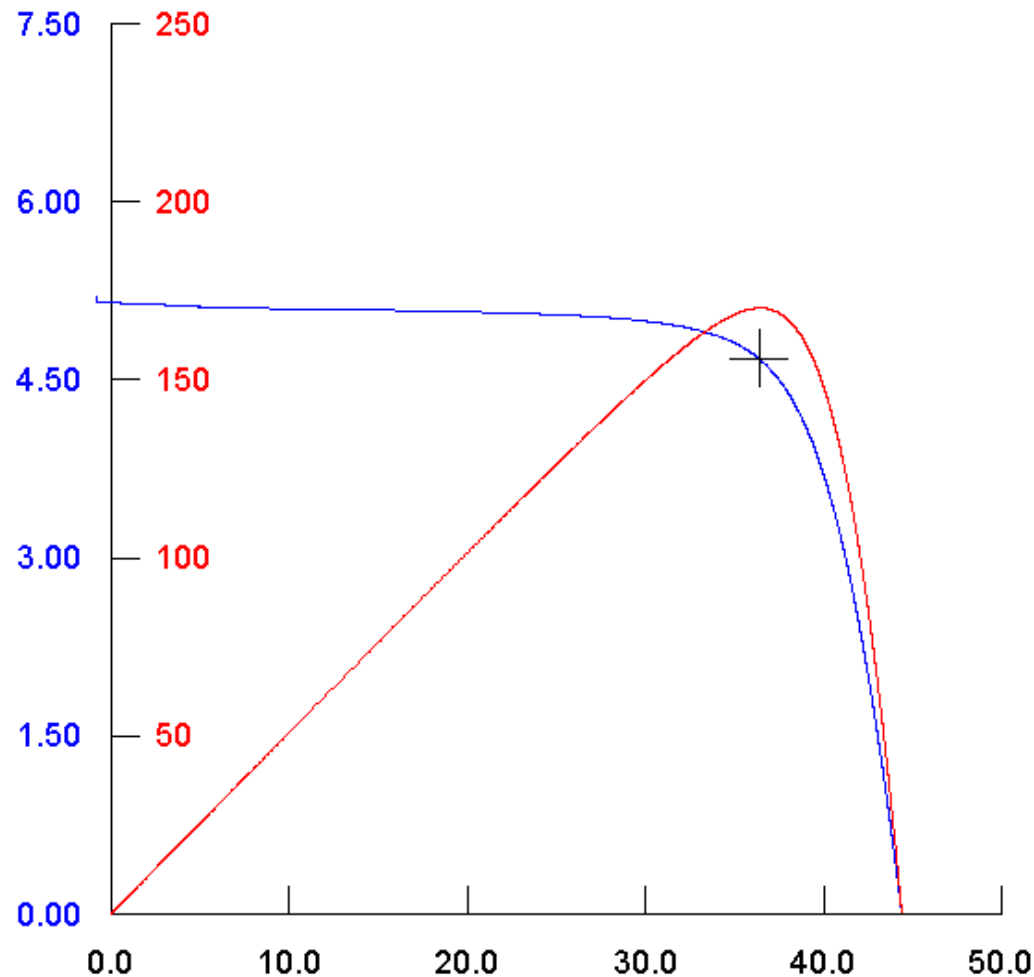
Temperature of 25°C

Irradiance: 1000 W/m²



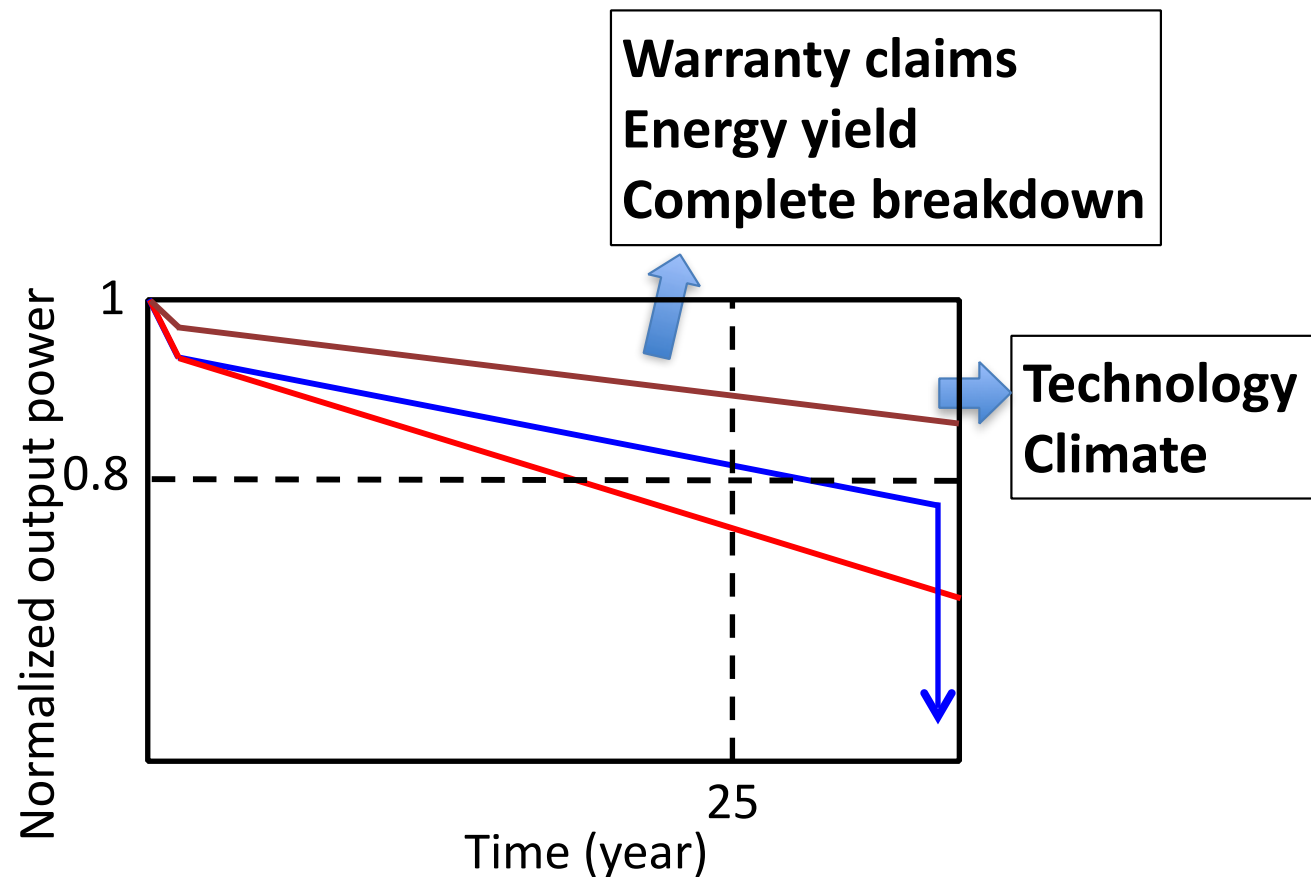
IV measurement of solar cells

Current, A Power, W

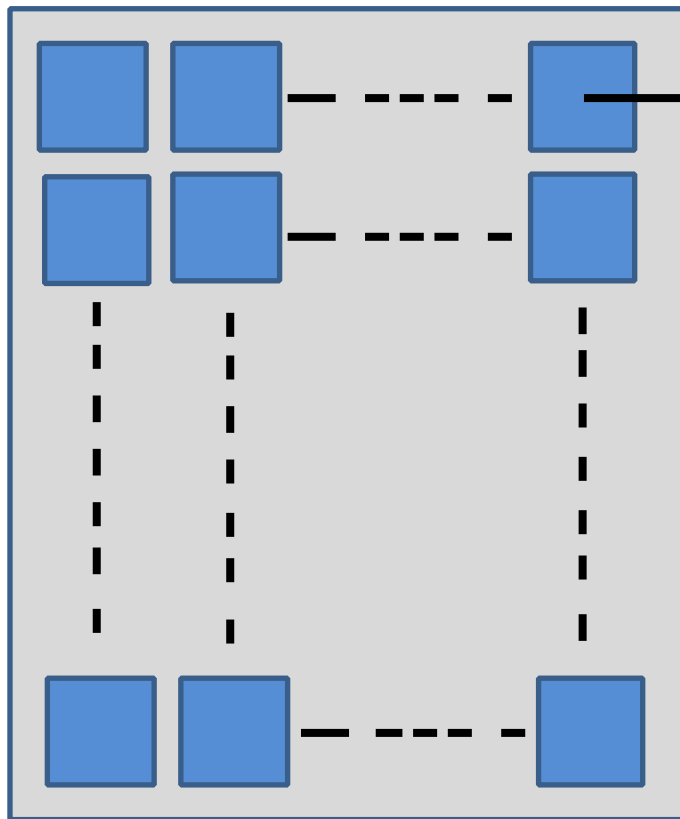


Measured Temp: 25.3 °C
 Corrected Temp: 25.0 °C
 Irr Meas: 99.9mW/cm²
 Irr Corr: 100.0mW/cm²
 Voc: 44.398V
 Isc: 5.146A
 Pmax: 170.129W
 Vpm: 36.411V
 Ipm: 4.673A
 FF: 0.745
 Eff,c: 15.901%
 Eff,m: 13.350%
 Rs: 0.857 Ohm
 Rsh: 177.865 Ohm
 MCCC1: 0.968
 MCCC2: 0.963
 Intensity V: 5.835V
 Capacitor Voltage: 2240V
 Load V: 7.180V
 Sampling Frequency: 240000 Hz
 Sweep Delay: 10 ms
 Sweep Length: 70 ms
 Sweep Direction: Isc->Voc
 IV Points: 2757

Implications of on-field degradation



What is PID?

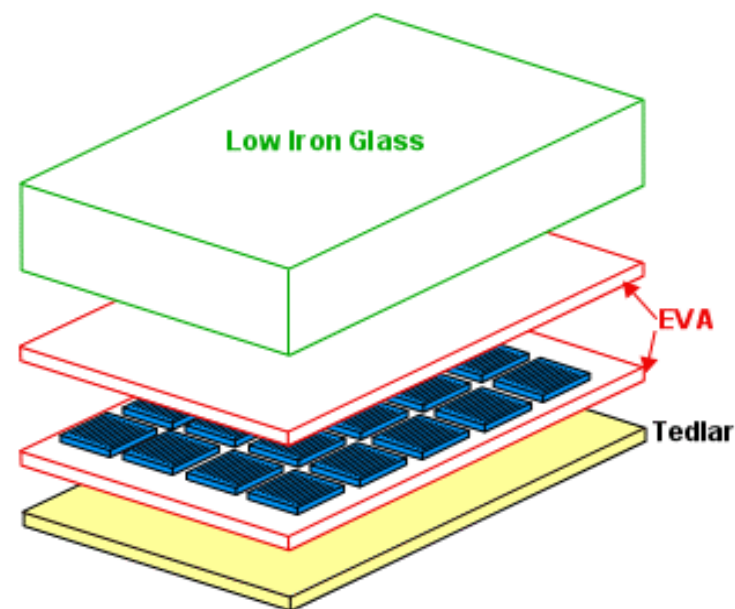
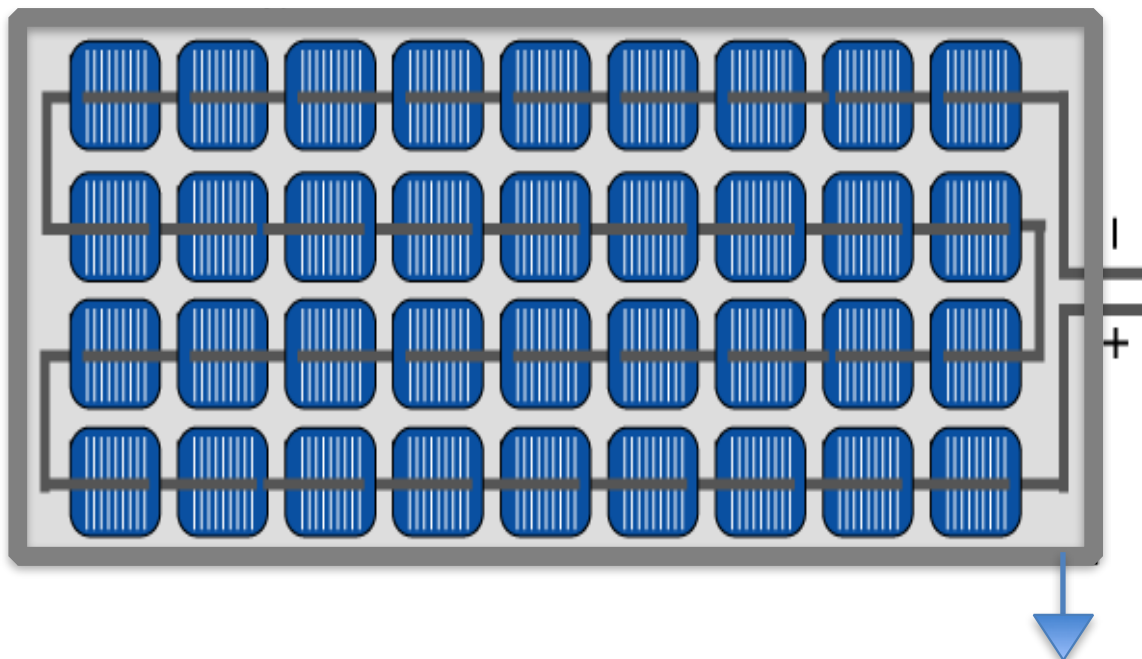


Solar PV
installation



PV Module

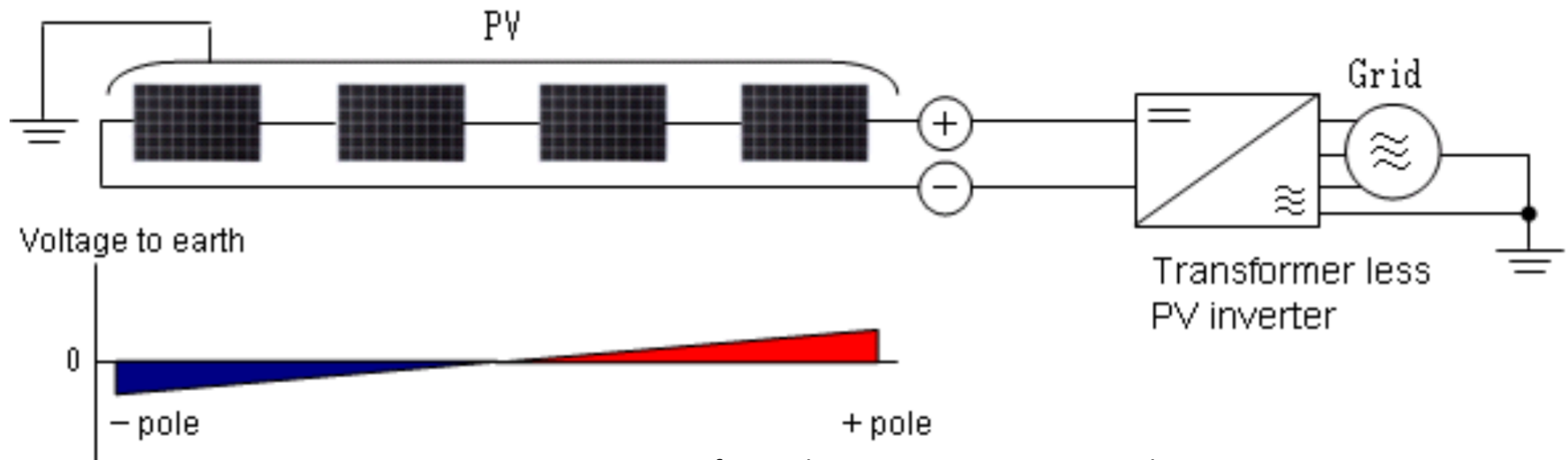
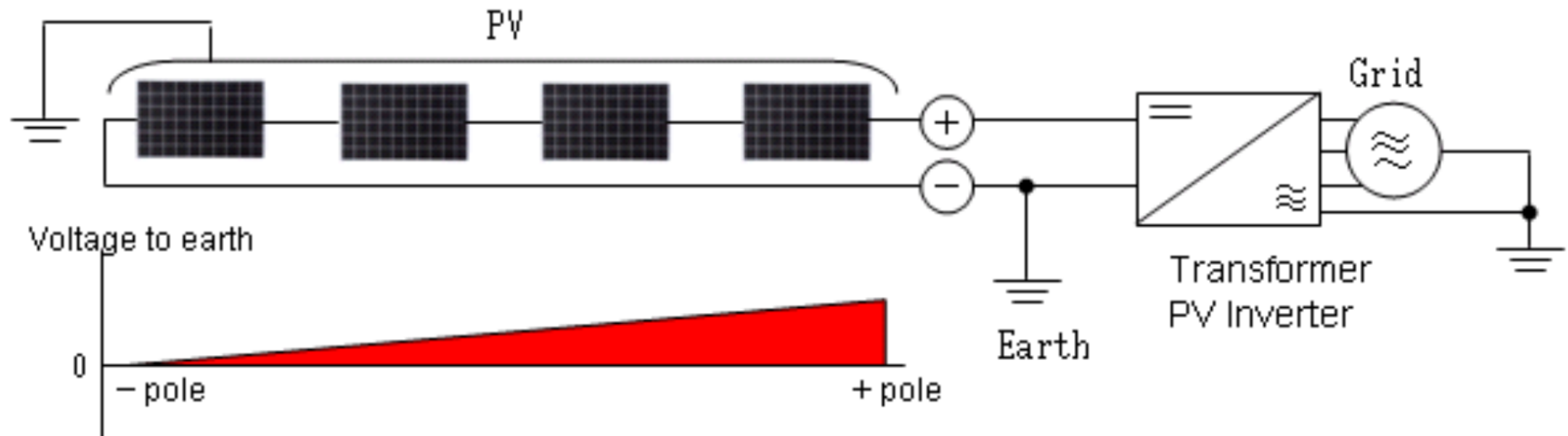
What is PID? (2)



Important components of a module:

- Front glass – Soda lime glass
- Encapsulant – Ethyl Vinyl Acetate (EVA)
- Solar cells
- Backsheet - Tedlar
- Frame – Aluminum

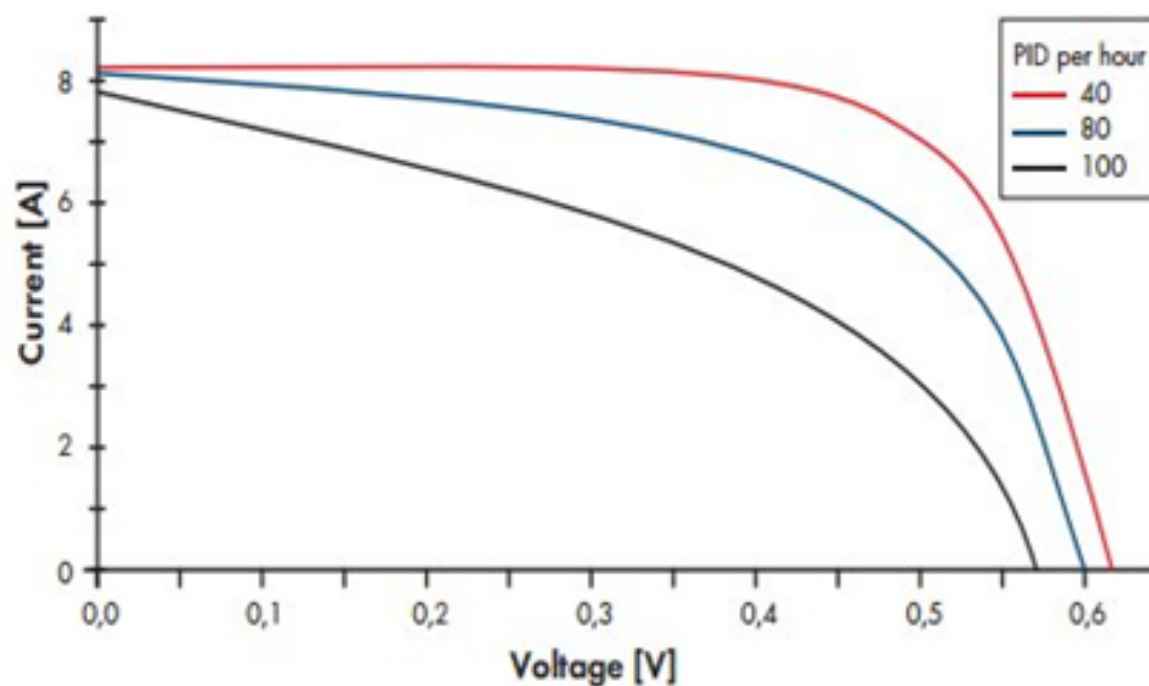
What is PID? (3)



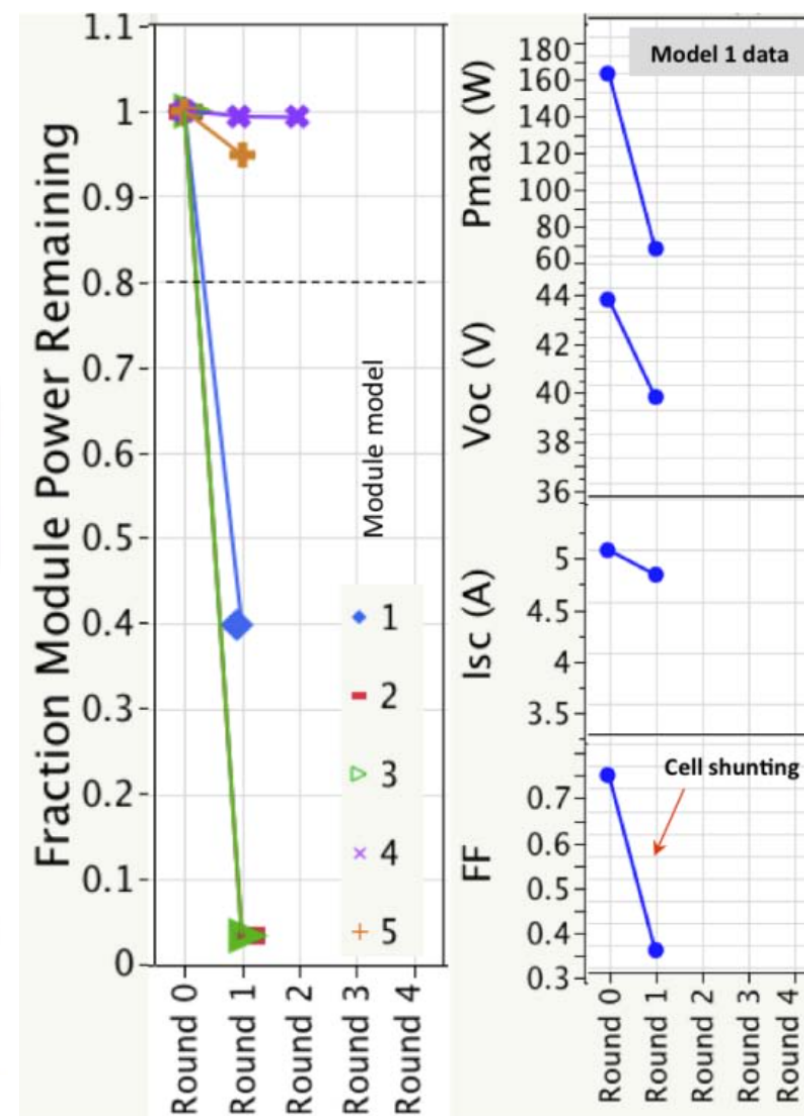
PID-preventive transformerless PV inverter, Omron white paper, 2013

What is PID? (4)

When modules are at the negative end of the string.

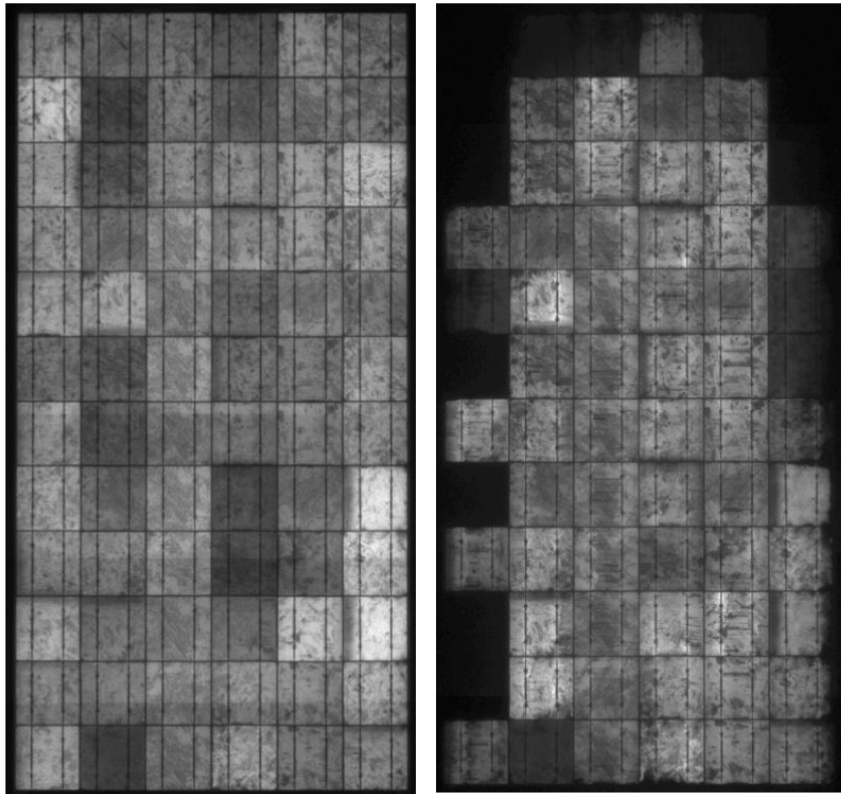


www.cenergymaxpower.com

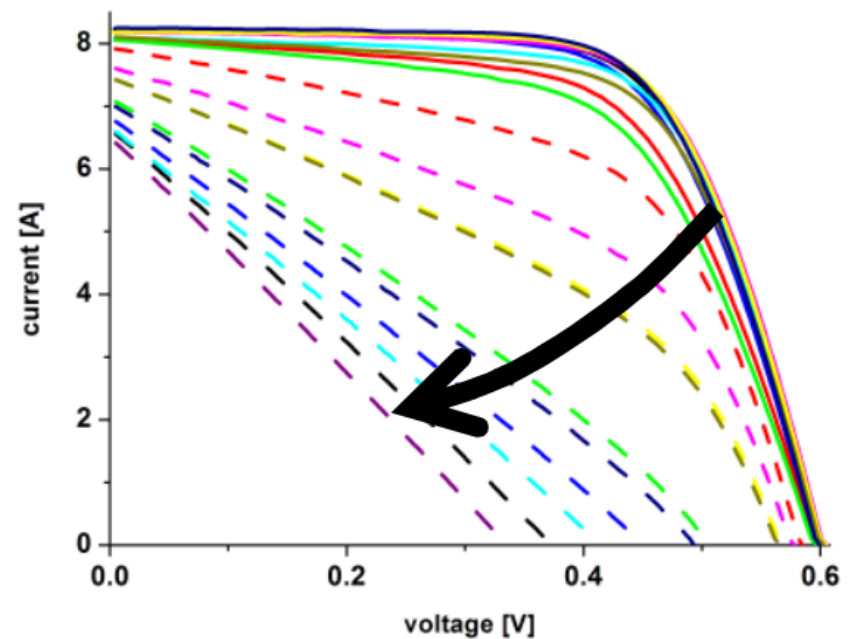
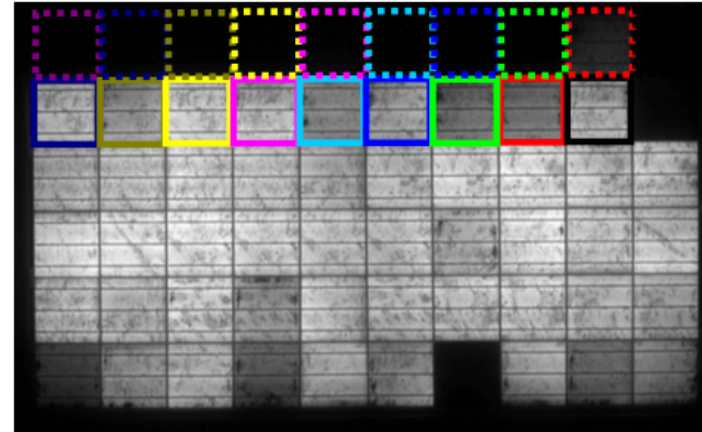


Hacke et al., EU PVSEC 2010

What is PID? (5)



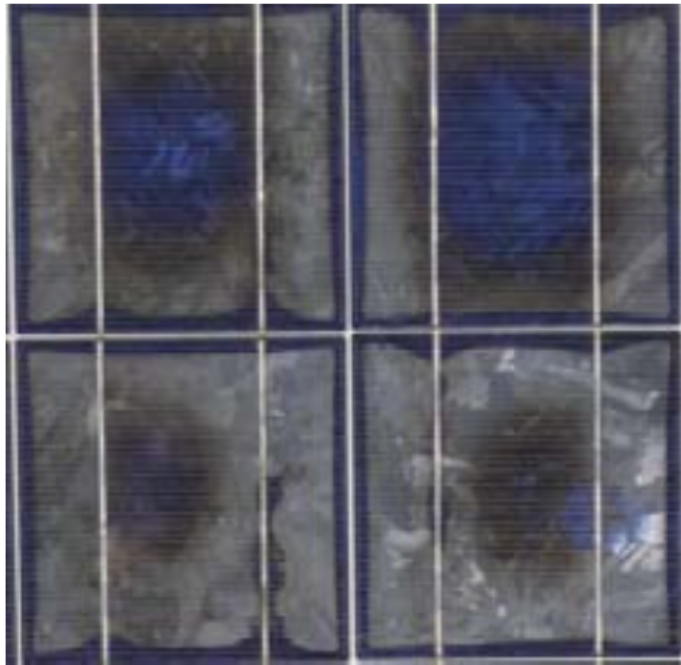
Hacke et al., NREL, 2014



Schuetze et al., IEEE PVSC 2011

PID is nonuniform across the module

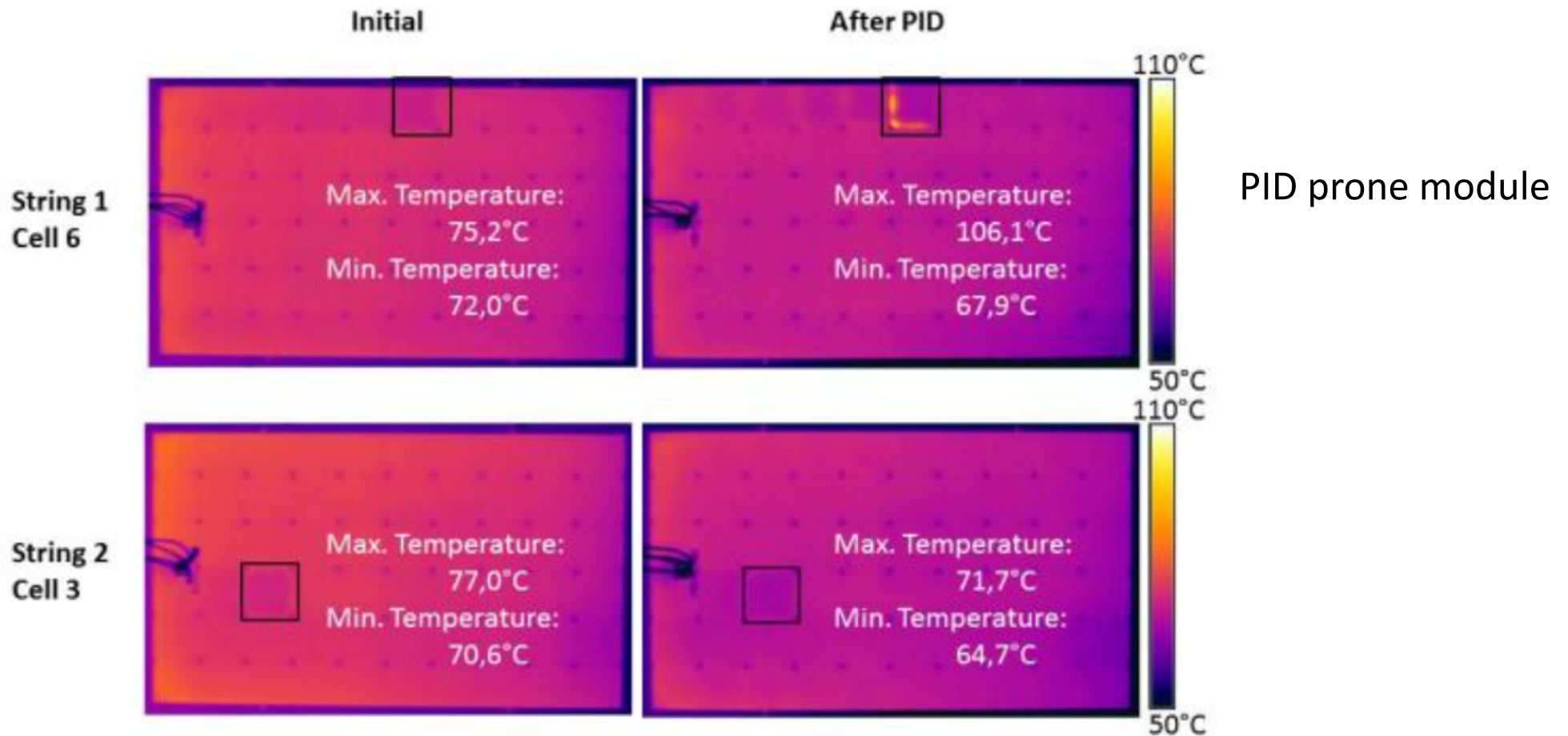
What is PID?



Silicon nitride is seen to be etched from the cells due to PID.
-600 V, 85C/85% RH, 1000 hrs.

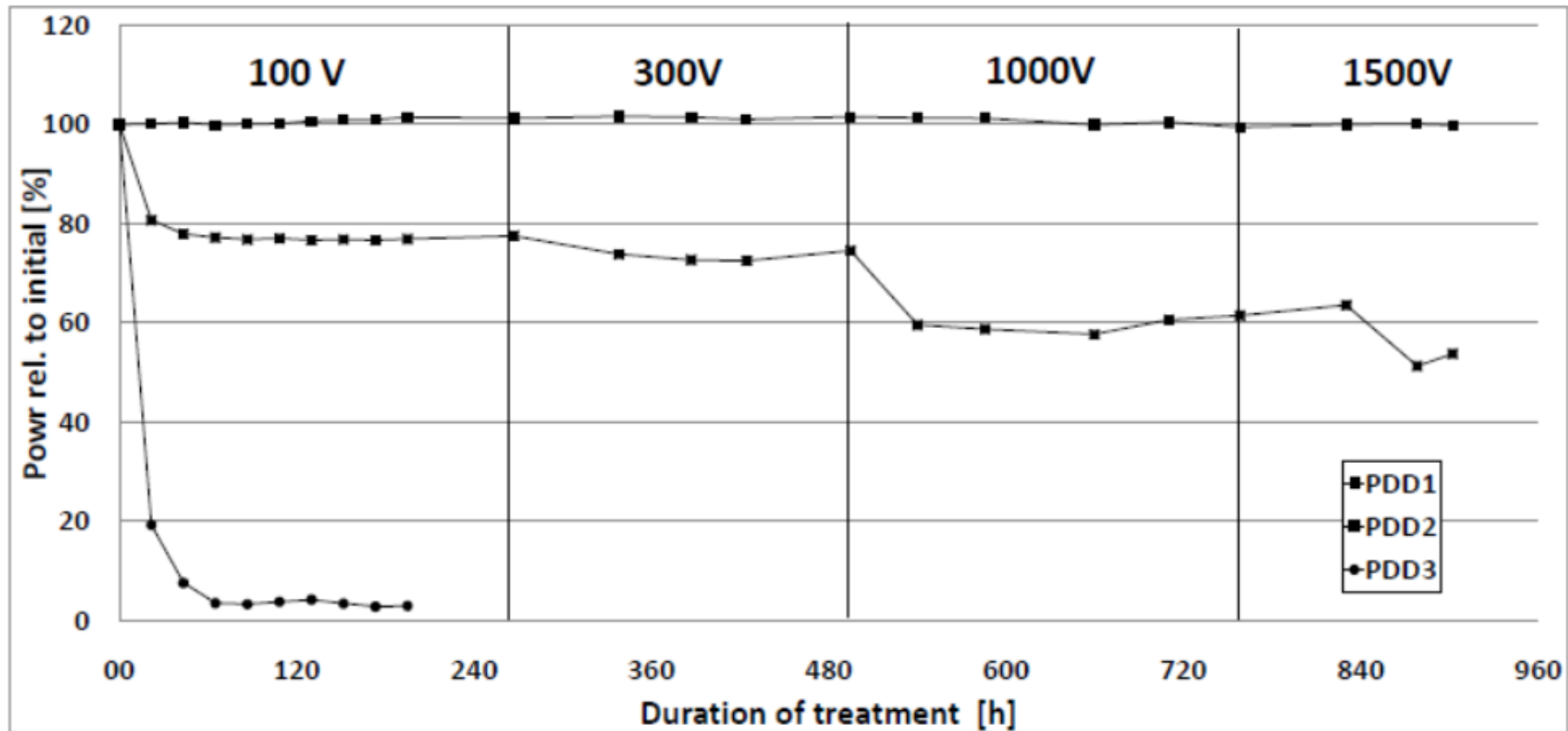
Hacke et al., EU PVSEC 2010

PID and hot spot



Koch et al., EU PVSEC 2012

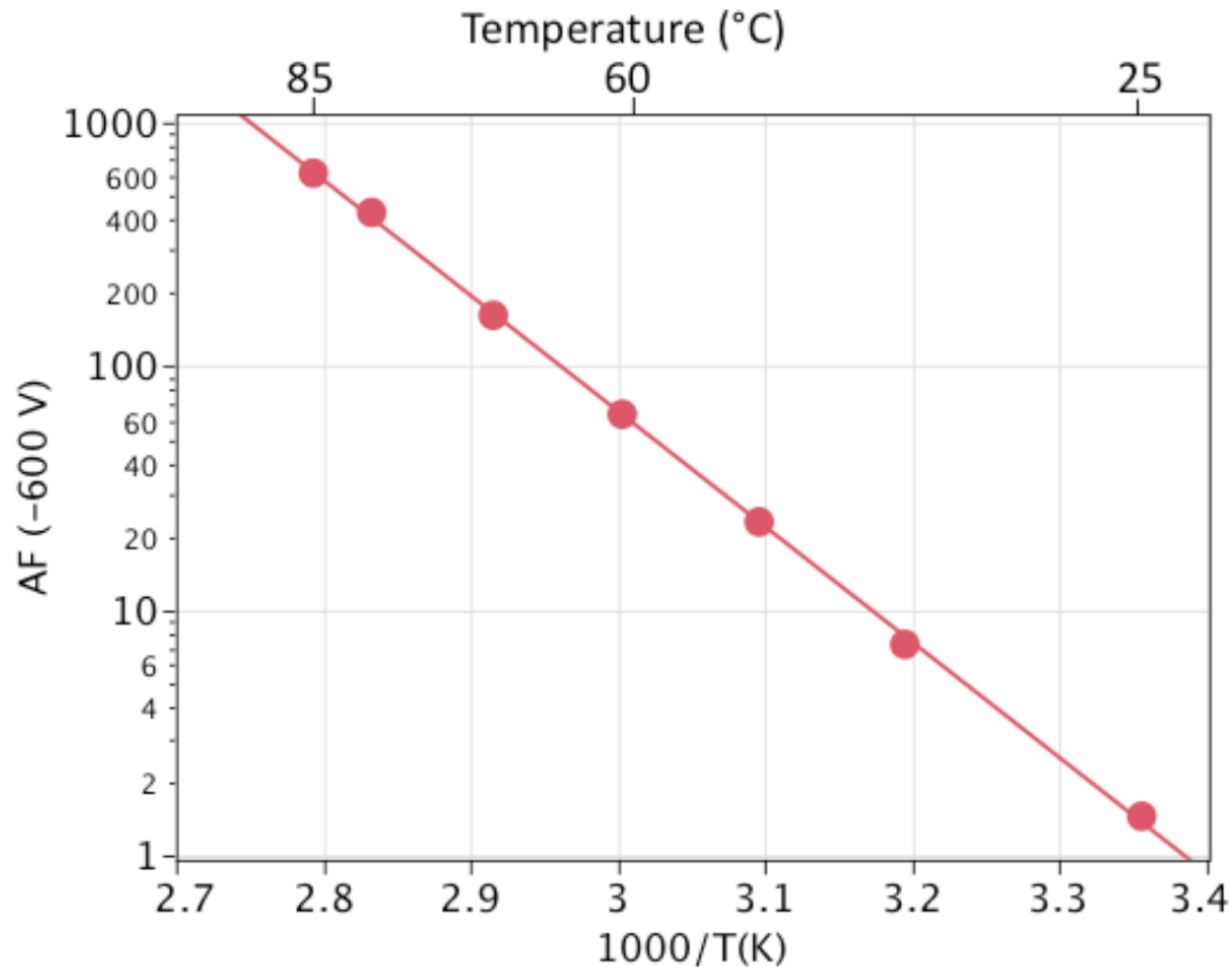
Impact of voltage



- PDDX – different module technologies
- All voltages are negative on the cells

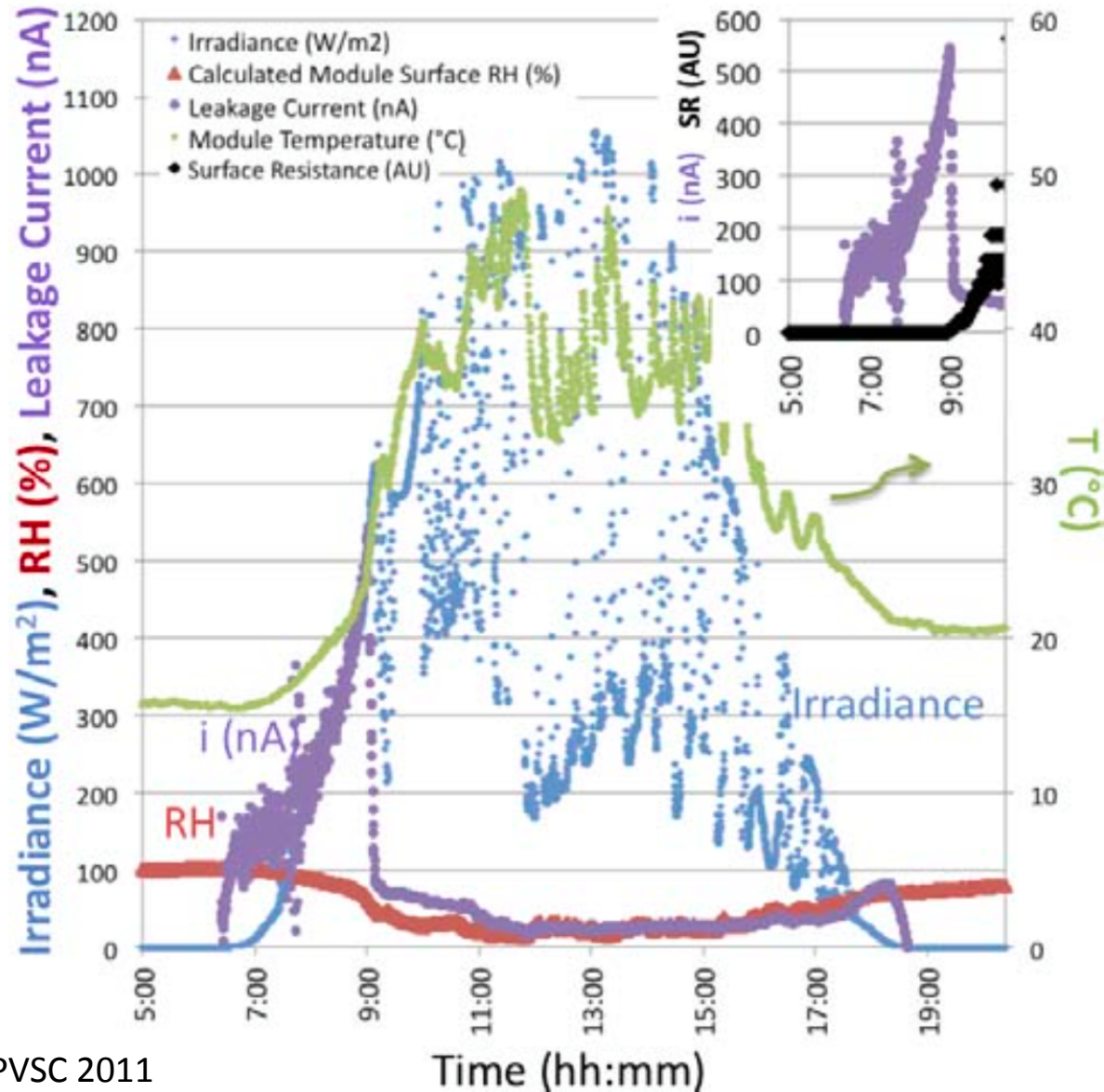
Koch et al., EU PVSEC 2011

Impact of temperature



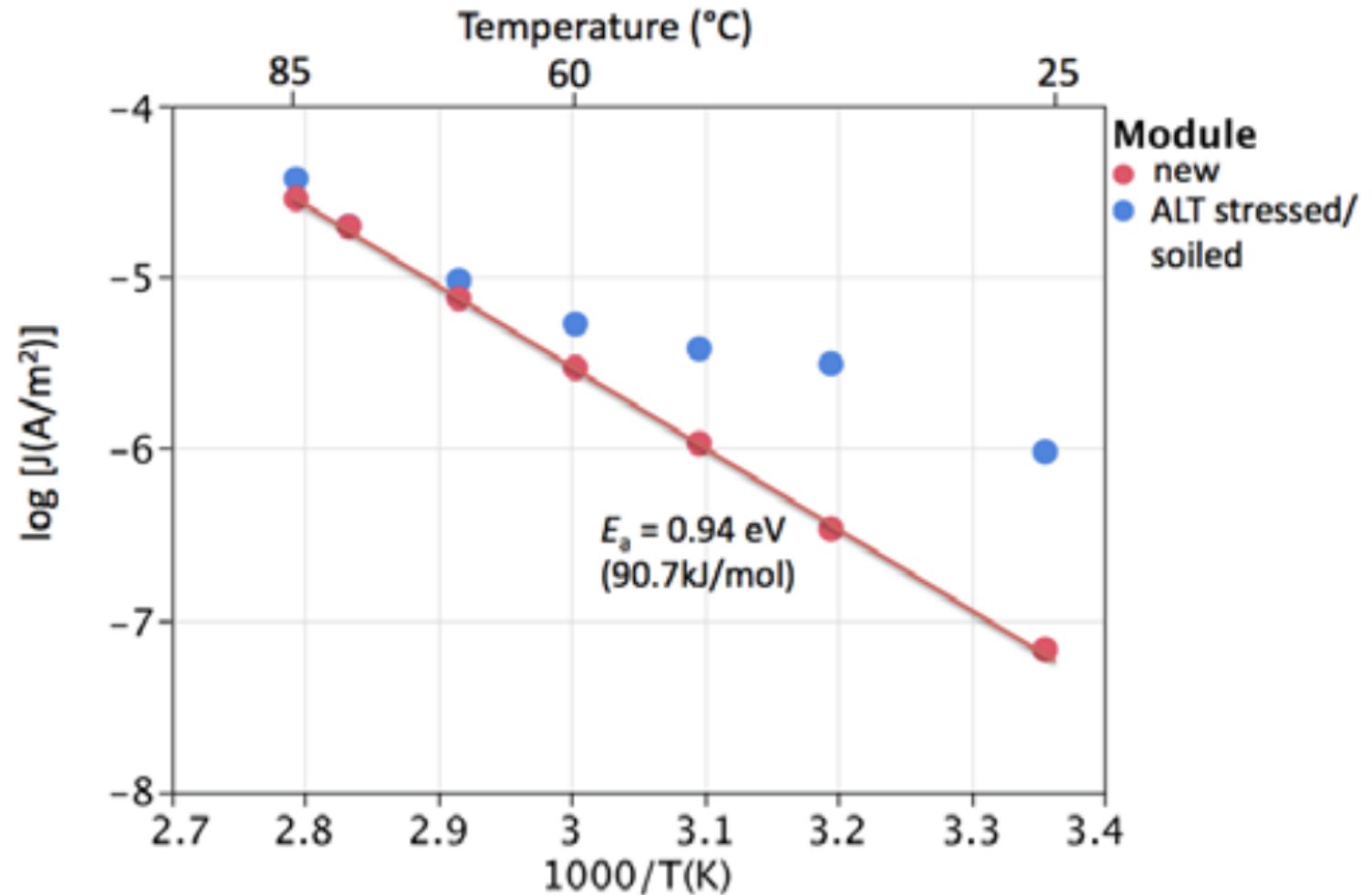
Hacke et al., IEEE PVSC 2011

Impact of humidity



Hacke et al., IEEE PVSC 2011

Impact of dust

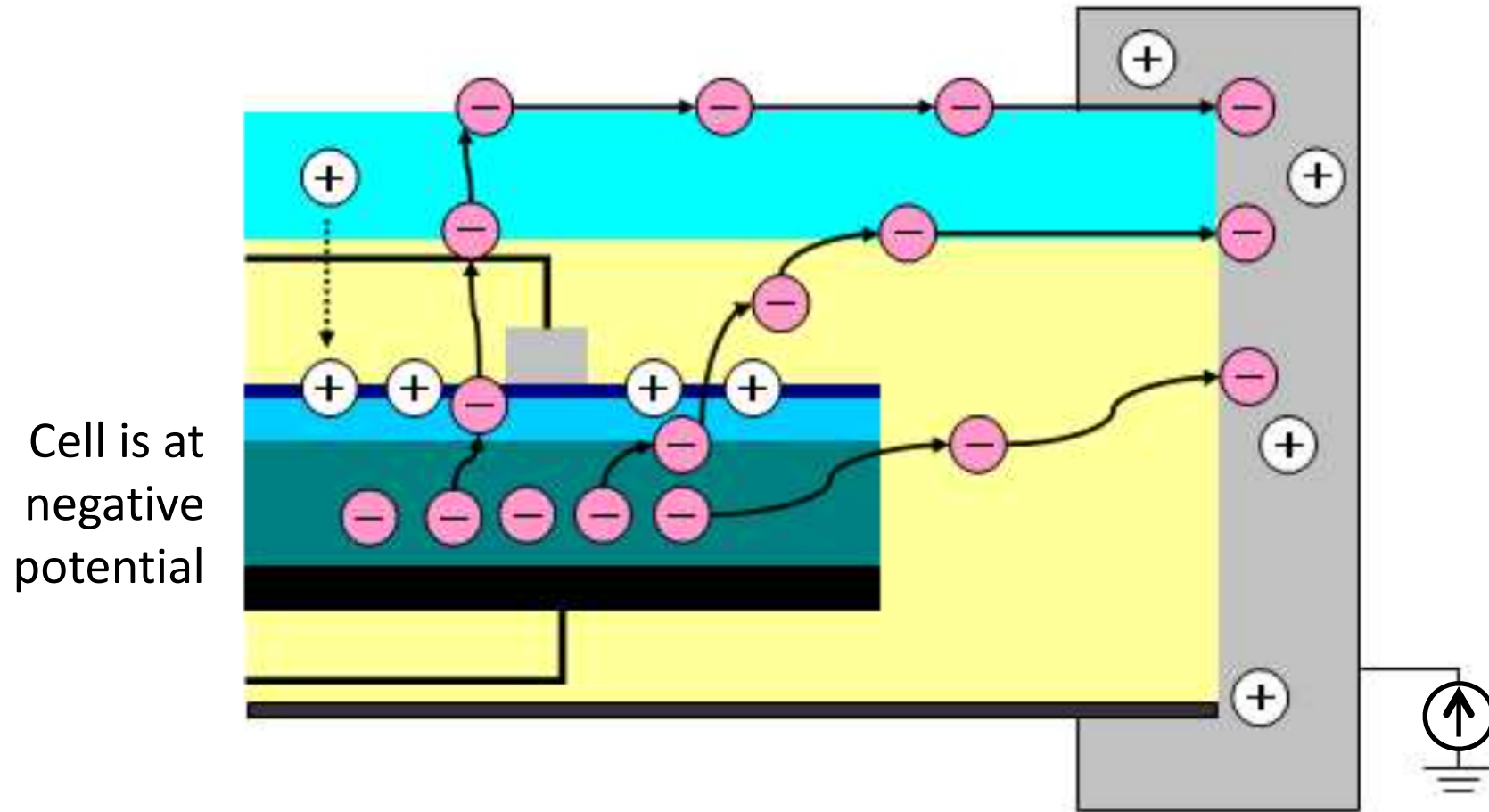


Hacke et al., IEEE PVSC 2011

PID - observations

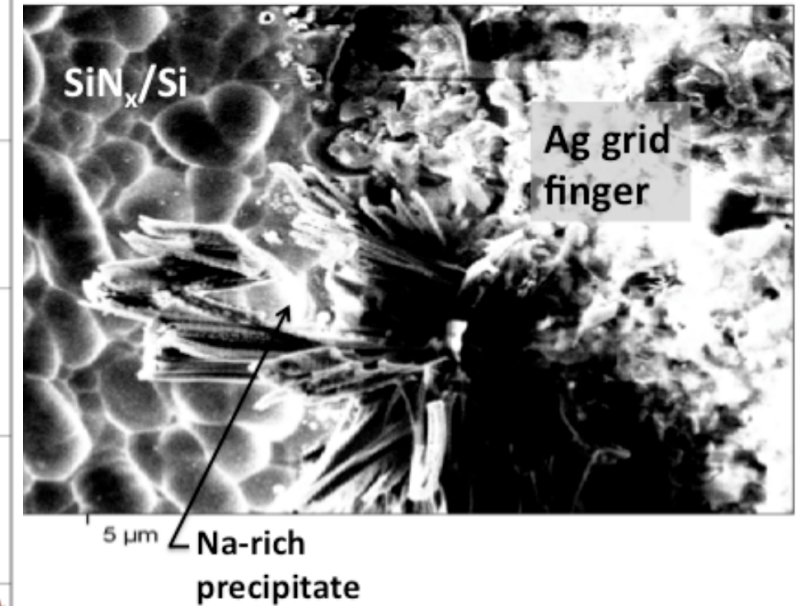
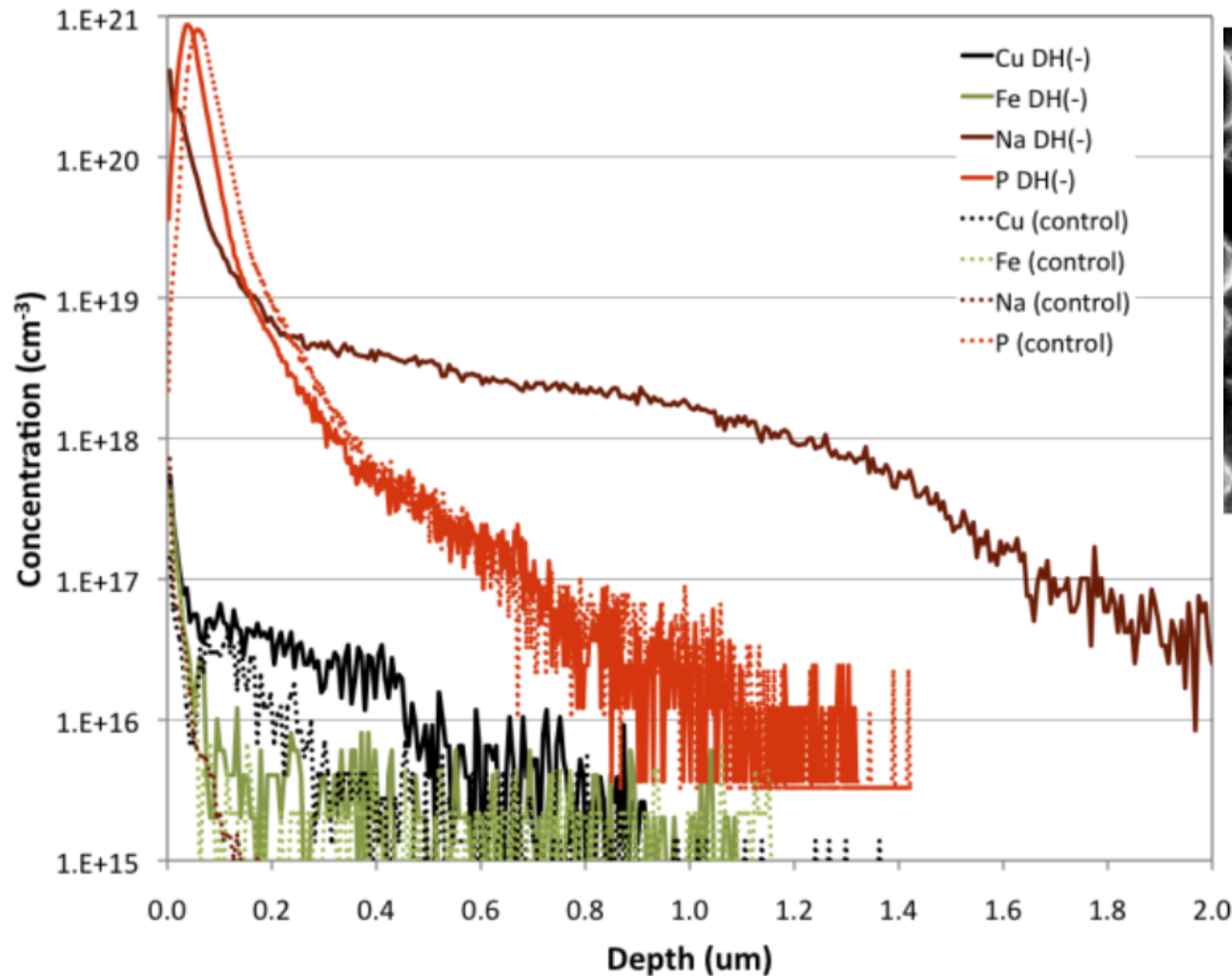
- Large power loss is seen in modules when they are at the negative end of strings
- The major component of loss is the FF loss, due to creation of shunts in the solar cells.
- Electroluminescence (EL) is a powerful tool to diagnose PID. NCPRE proposed day-light EL could be deployed in field for this.
- Degradation is nonuniform across the module, and is seen to be more severe near the frame.
- Degradation is accelerated by voltage, temperature, humidity and **dust**.

PID mechanism



www.cenergymaxpower.com

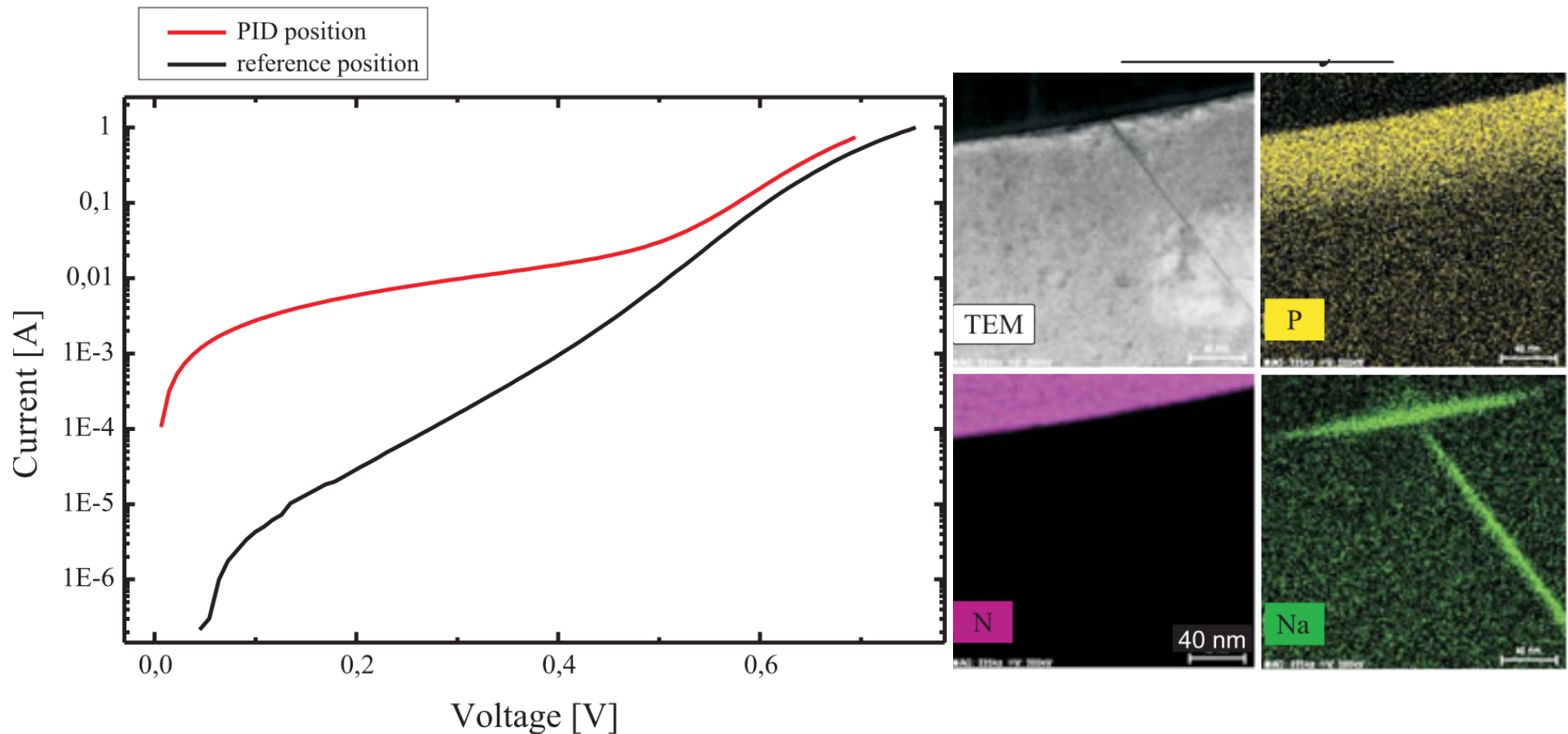
PID mechanism – role of sodium



Hacke et al., IEEE PVSC 2011

Hacke et al., EU PVSEC 2010

PID mechanism – role of sodium

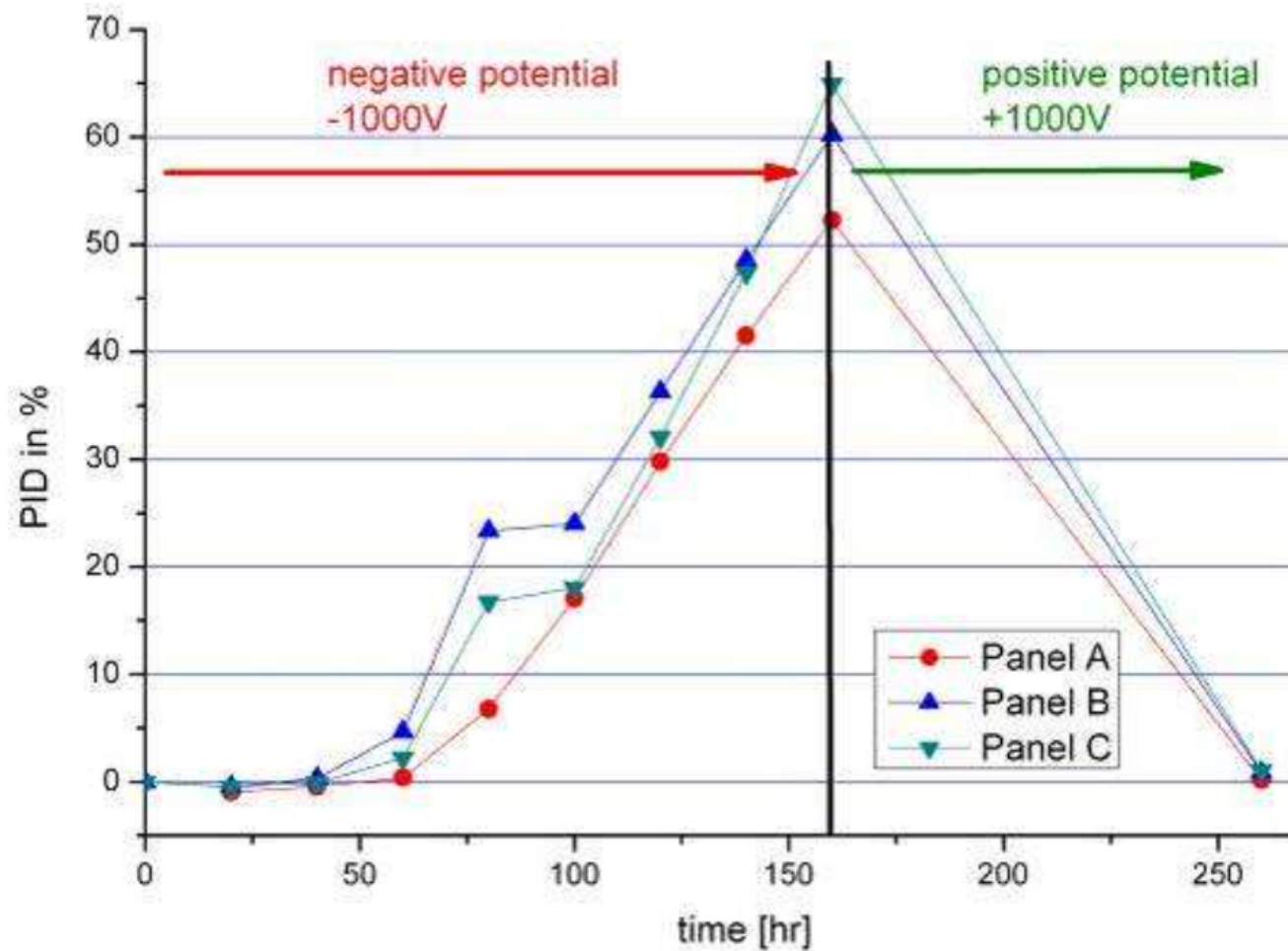


Lausch et al., IEEE Journal of Photovoltaics 2014

Explaining PID

- Under wet (snow, humid and dusty,) conditions, the glass is at ground potential leading to high electric field towards the cell.
- Na^+ ions from the glass migrate to the cell through encapsulant and SiN_x (ARC).
- Decoration of defect in silicon by Na^+ leading to shunts and PID.
- The role of humidity (+dust) is to spread the ground contact on the glass surface. Closer to the frame, PID is more severe.
- The ion mobility in glass and encapsulant enhances with temperature. Activation energy of the PID is seen to be close to that of ion transport in glass in many cases.
- Localized poor contact between encapsulant and the ARC result in nonuniform PID even in lab tests.

PID recovery



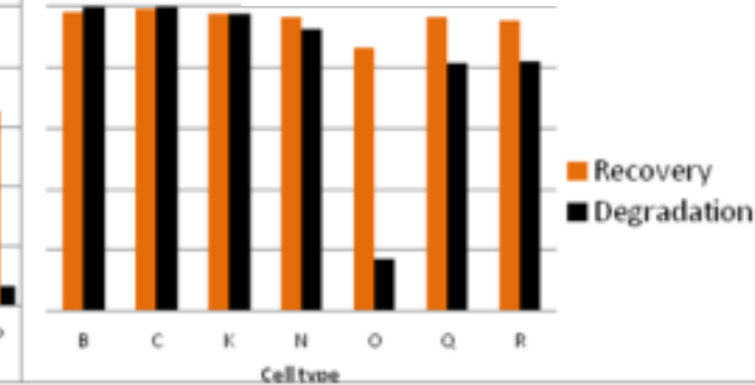
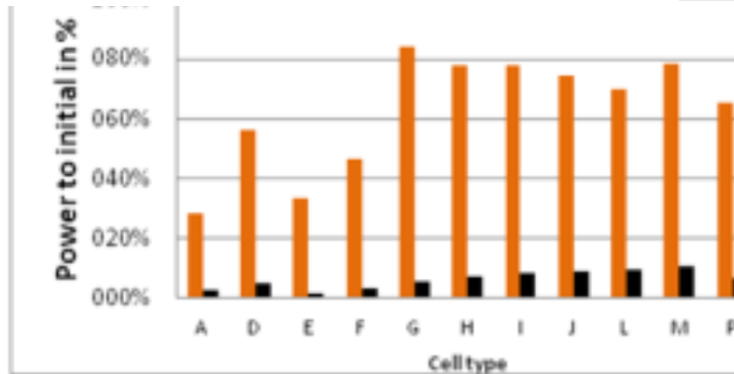
Pingel et al., EU PVSEC 2010

PID Recovery

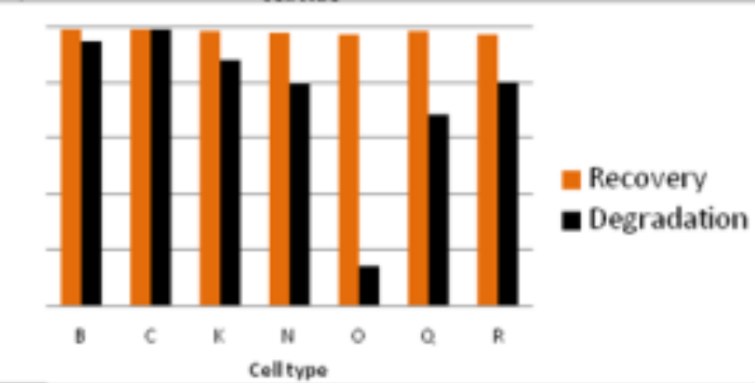
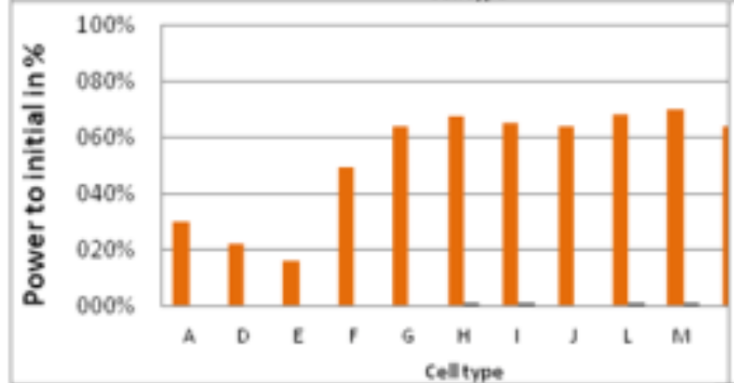
left over power after PID < 15%

left over power after PID > 15%

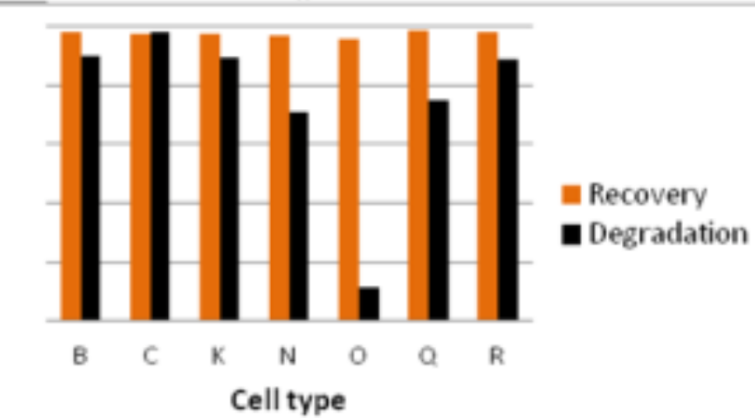
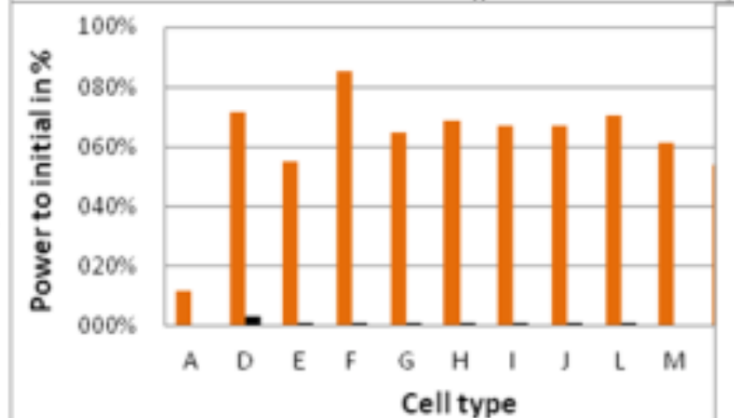
25°C



60°C



85°C

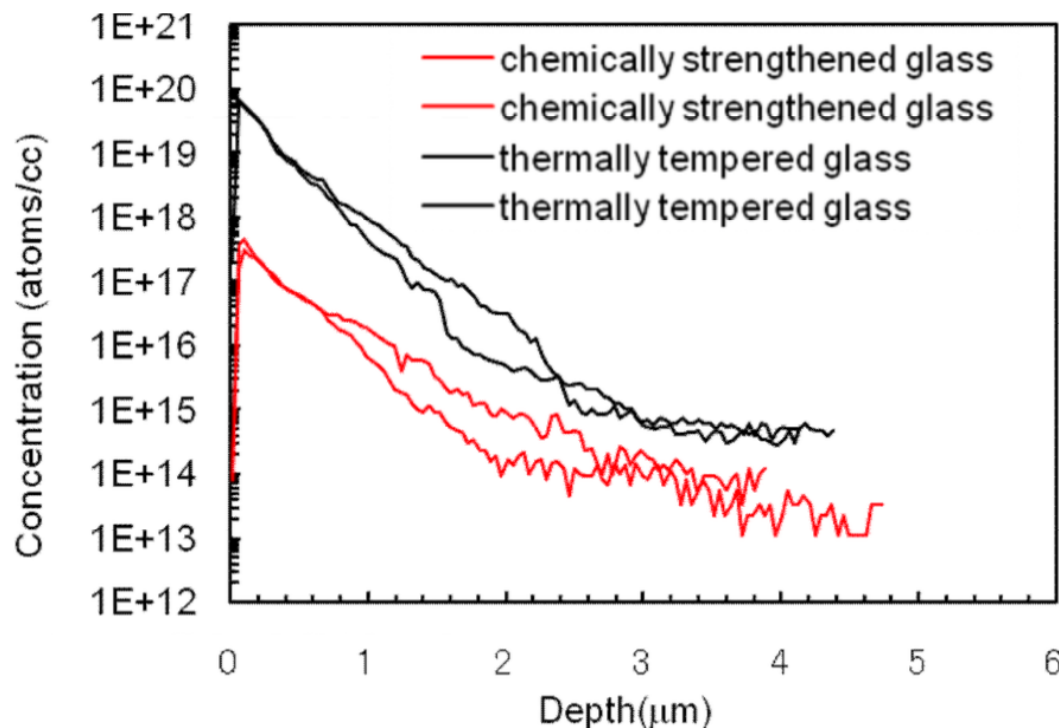
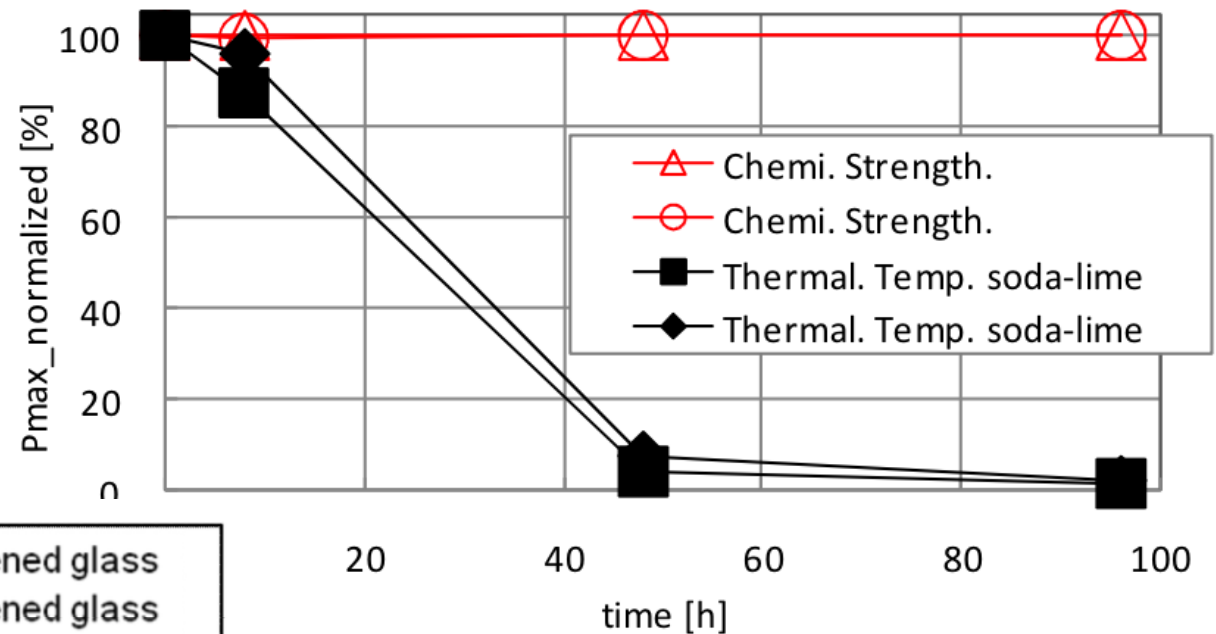


PID – Mitigation Strategies

- Due to large negative potential resulting in Na^+ transport from the glass through the EVA and ARC to the cells
- Accelerated by temperature and humidity – out of our control in field
- Would be smart not to count on recovery
- Mitigation:
 - **Keep the modules clean (maintenance)**
 - **Operate strings with only positive and ground (system level)**
 - **Reduce sodium in glass or add barrier layers in glass (module)**
 - **Increase the sodium transport resistance of encapsulant (module)**
 - **Increase the sodium transport resistance of SiN_x (cell level)**
 - **More robust emitter design and use of low defect silicon (cell level)**

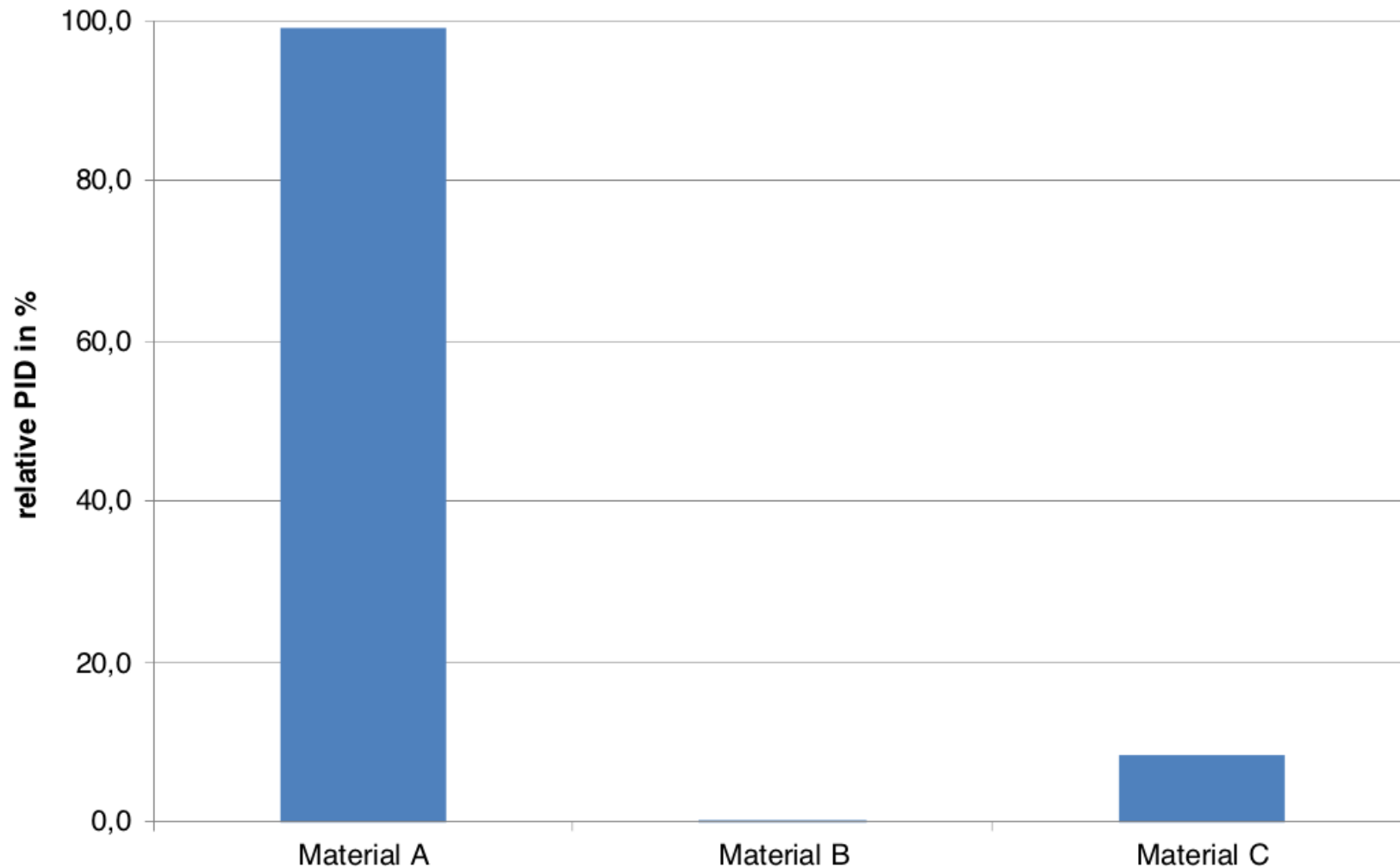
Modification of glass

- Na replaced with K at the surface of the glass
- Resistivity increases by 2 to 3 orders of magnitude

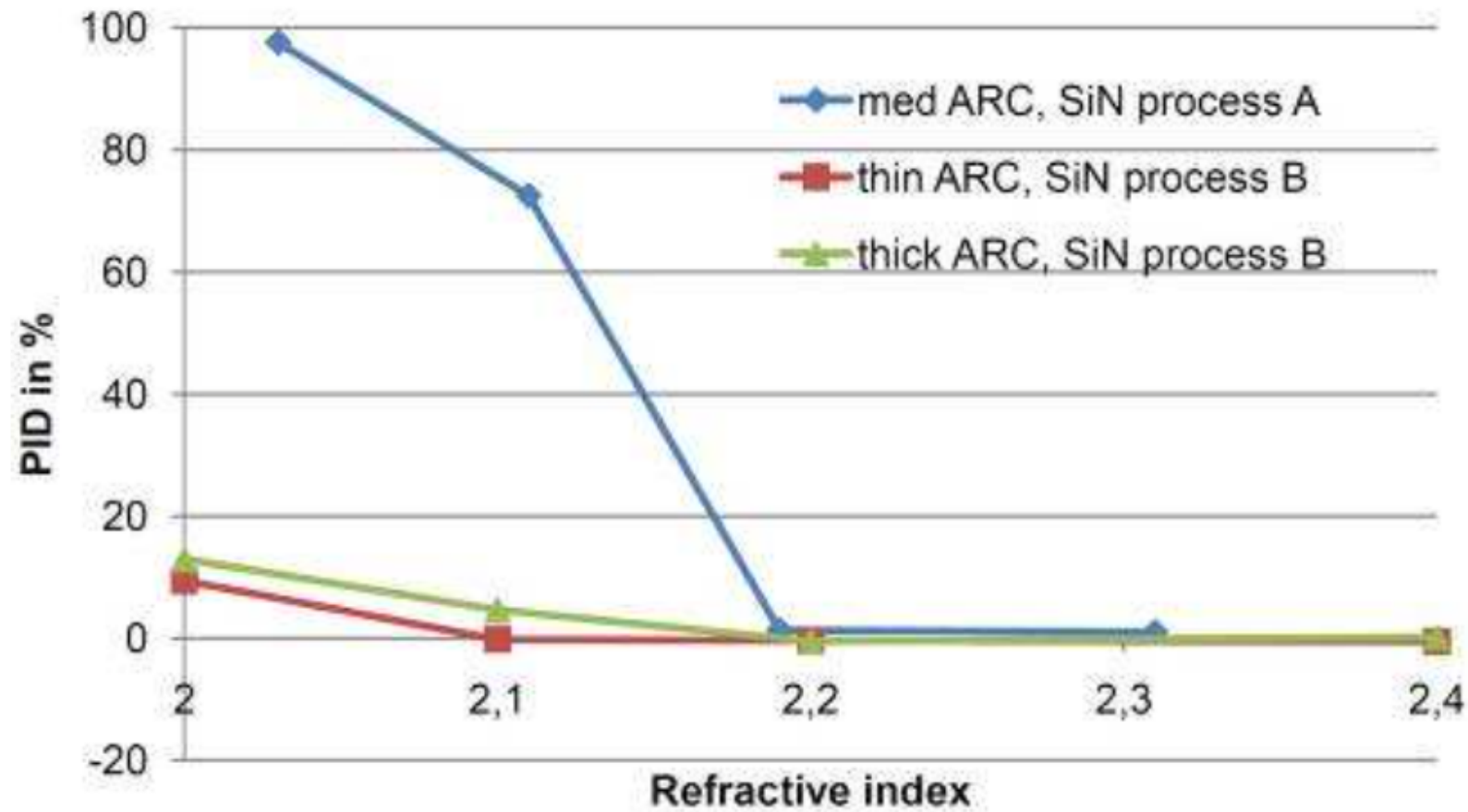


Kambe et al., IEEE PVSC 2013

Impact of encapsulant



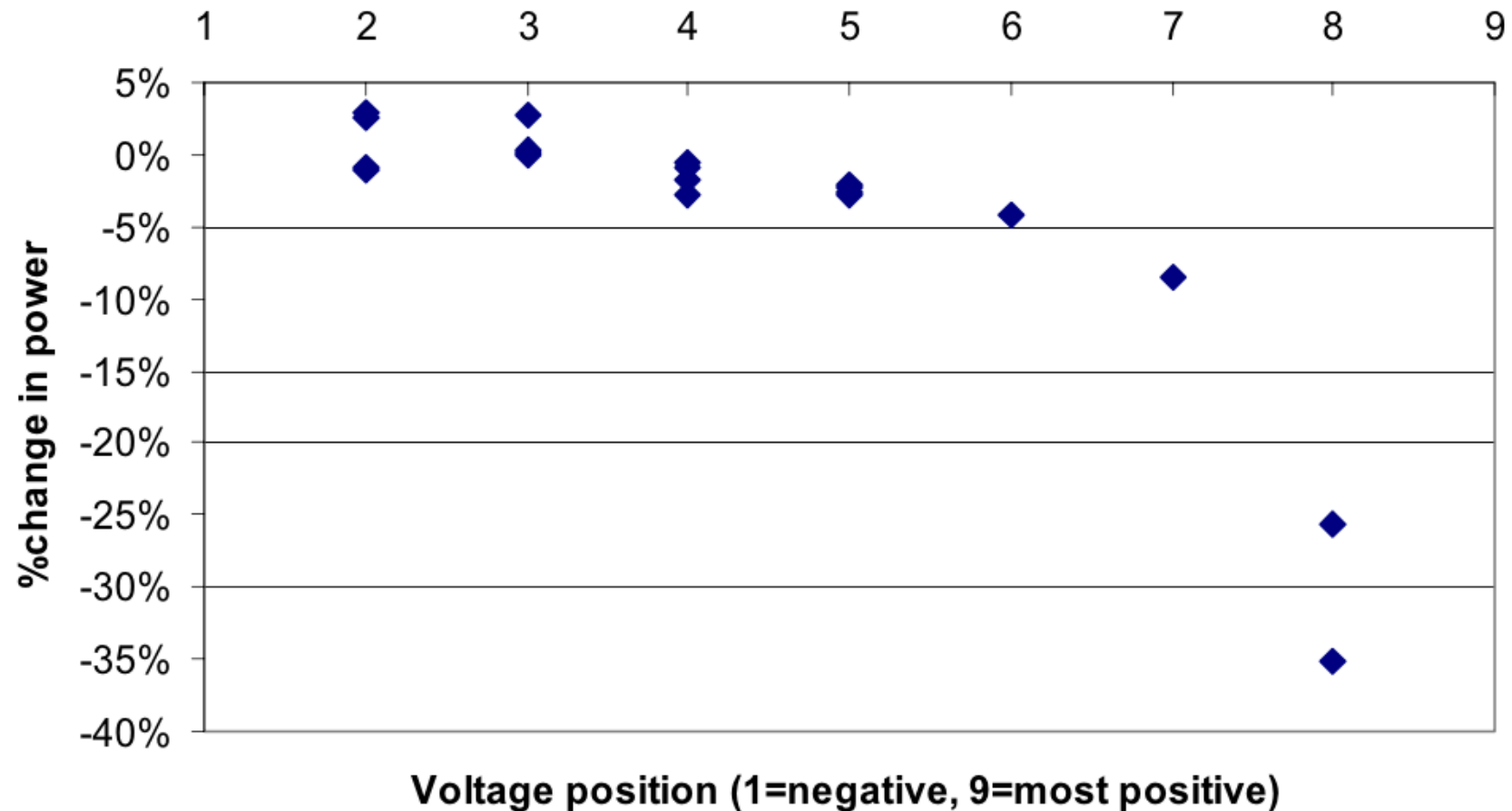
Impact of SiNx ARC



Pingel et al., EU PVSEC 2010

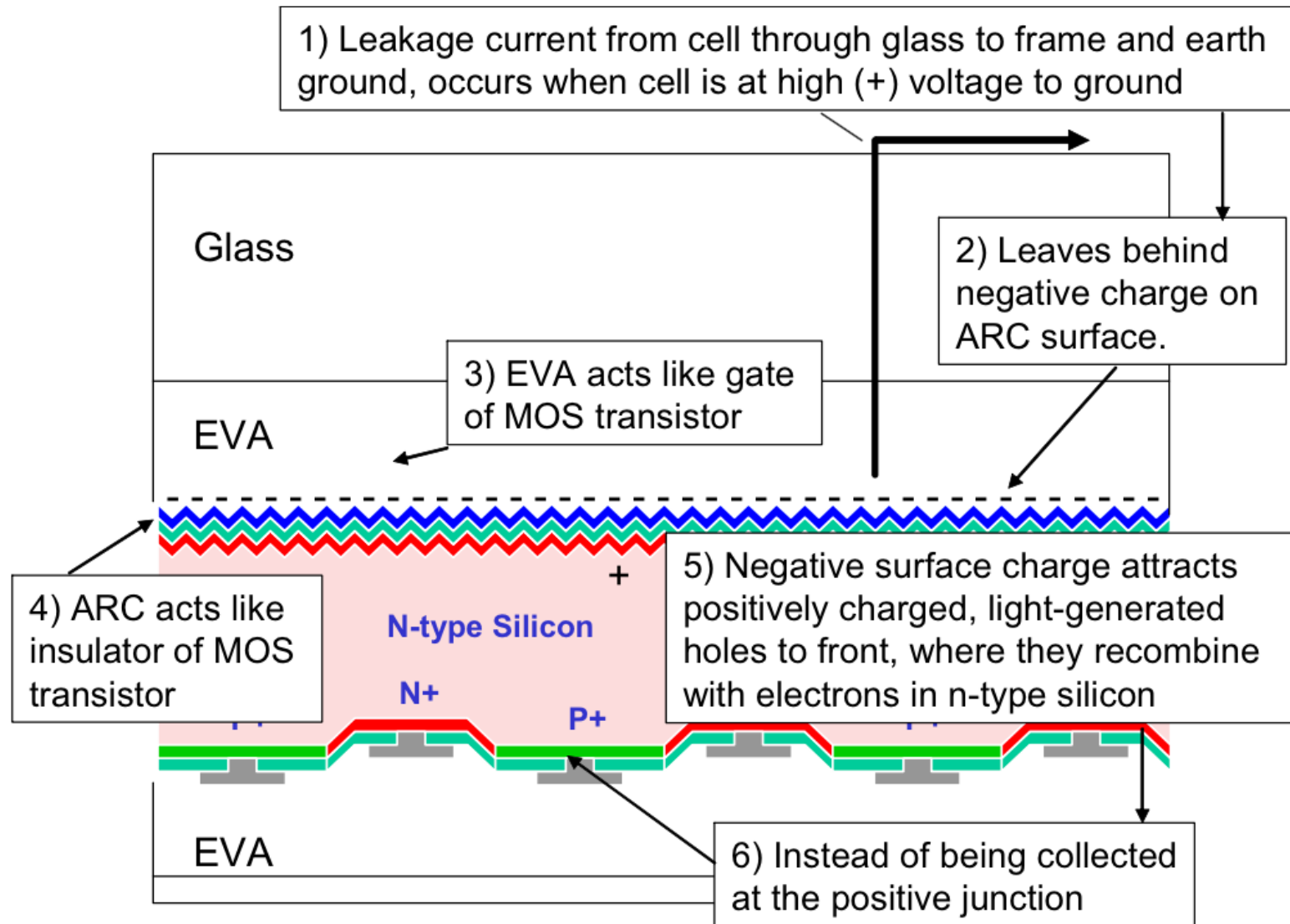
What about positive polarity?

Positive polarity stress on cells



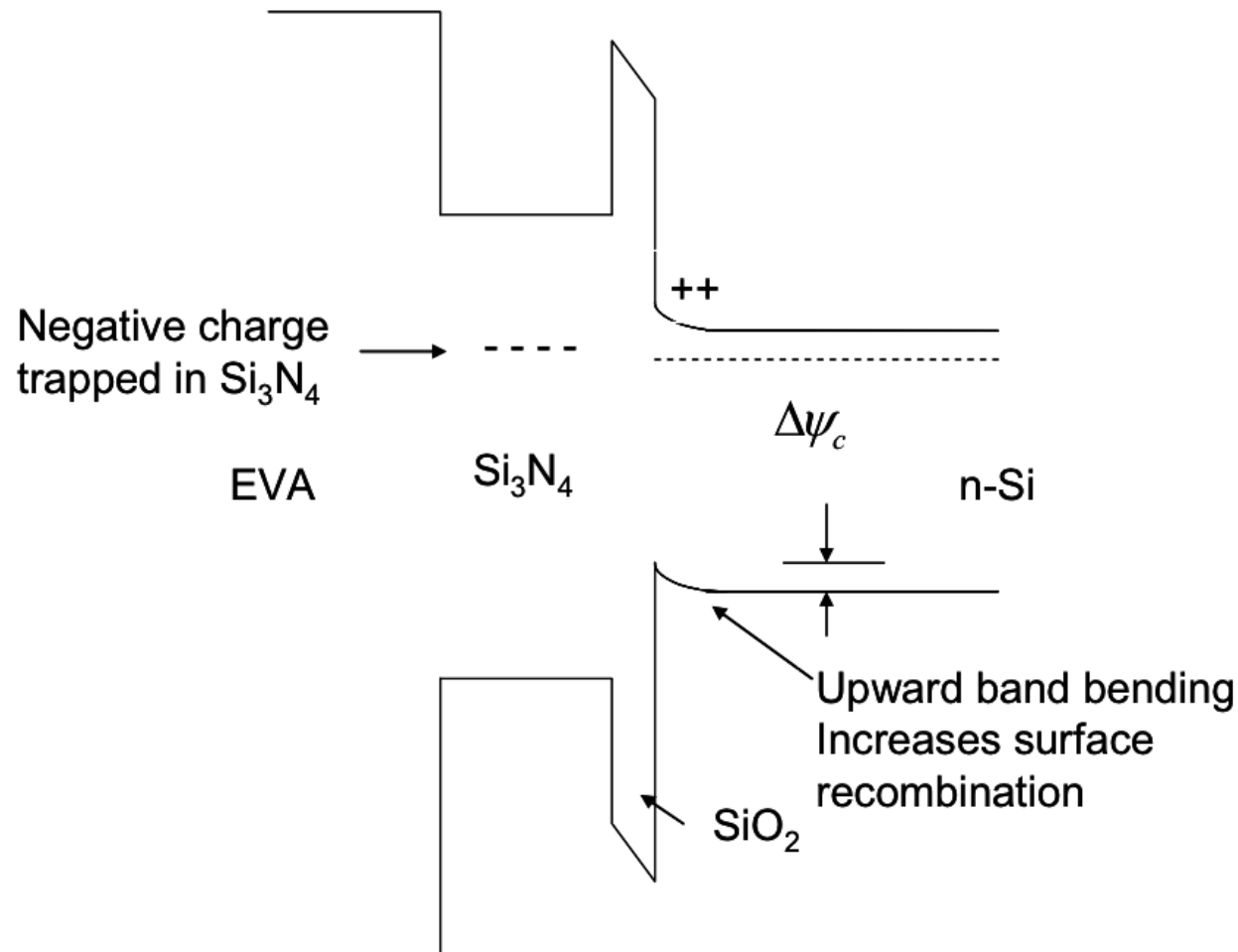
Swanson et al., EU PVSC 2005

PID in positively biased cells



Swanson et al., EU PVSC 2005

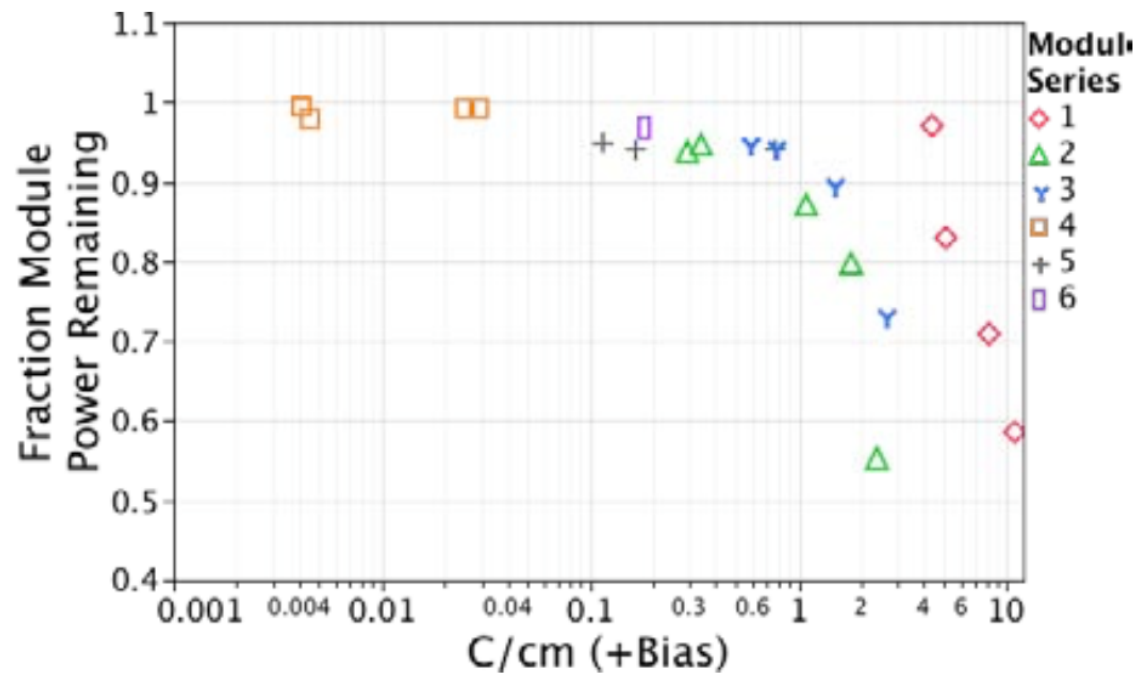
PID in positively biased cells



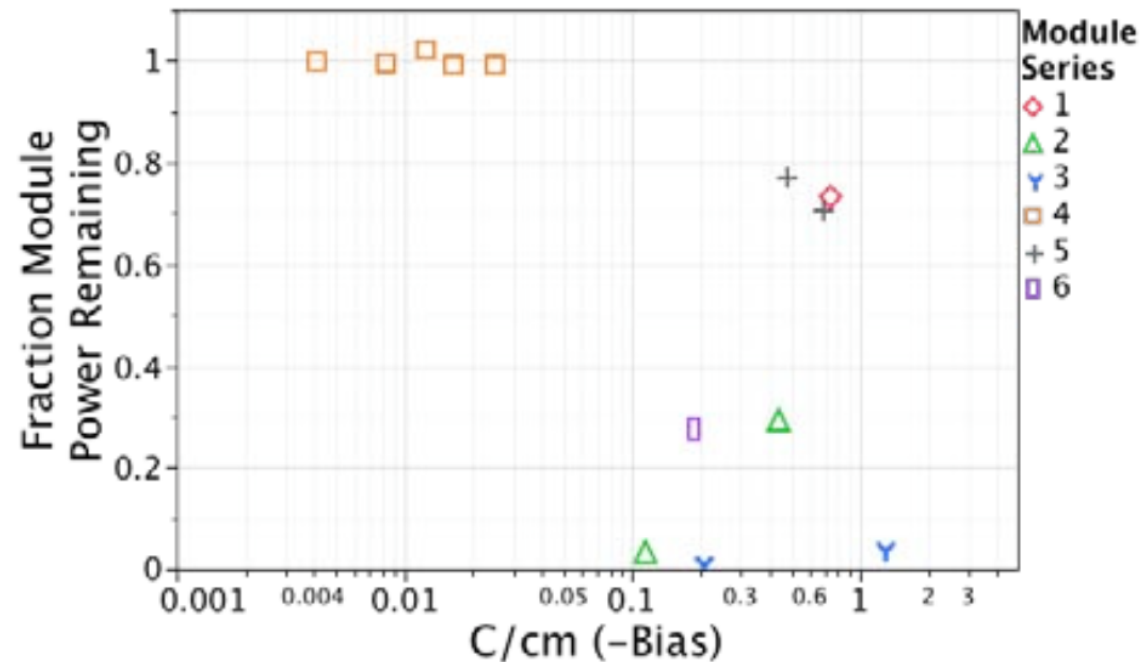
Recovered by UV irradiation.

PIC

Positive stress



Negative stress



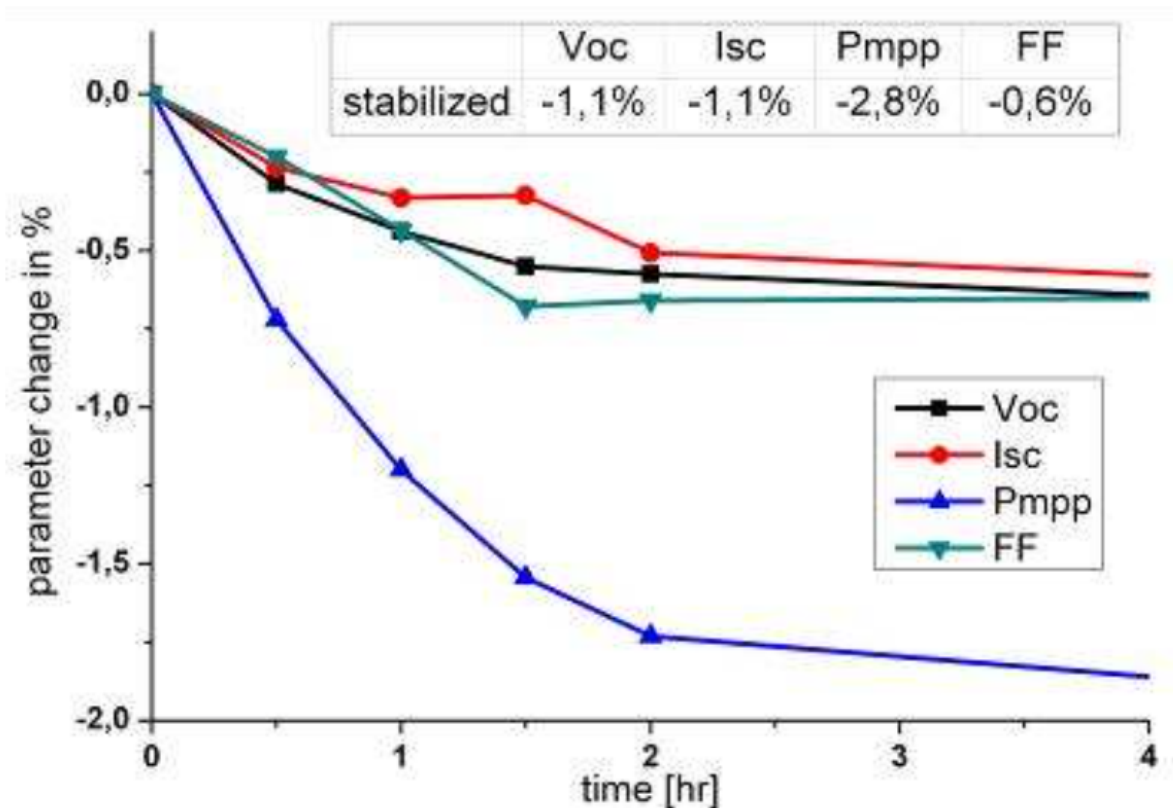
PID – Test standard

- IEC 62804 is under preparation
- Draft test procedure
 - Chamber air temperature $60\text{ }^{\circ}\text{C} \pm 2\text{ }^{\circ}\text{C}$
 - Chamber relative humidity $85\% \pm 5\% \text{ RH}$
 - Test duration 96 h
 - Voltage: module nameplate rated system voltage (e.g.: 1000 V), 2 for each polarity, 1 module supplied for control, voltage applied during temperature ramps
 - Pass criterion: both modules of a tested polarity must show < 5% power degradation and pass IEC 61215 ed. 2 visual inspection criteria

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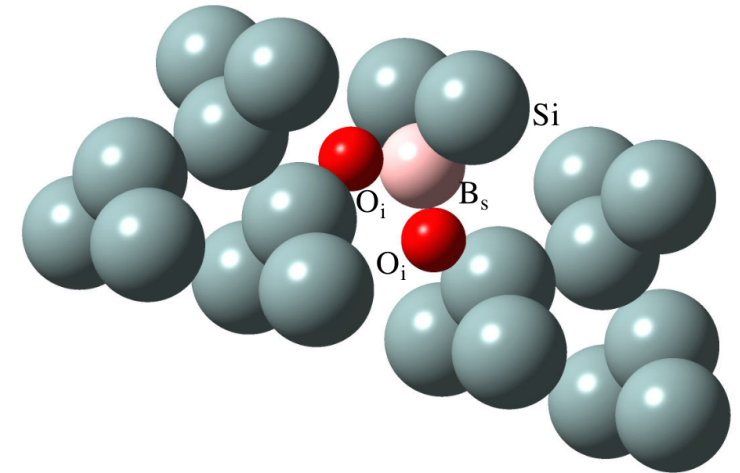
What is LID?



Performance of cells and modules is seen to degrade at a fast rate during the initial operation.

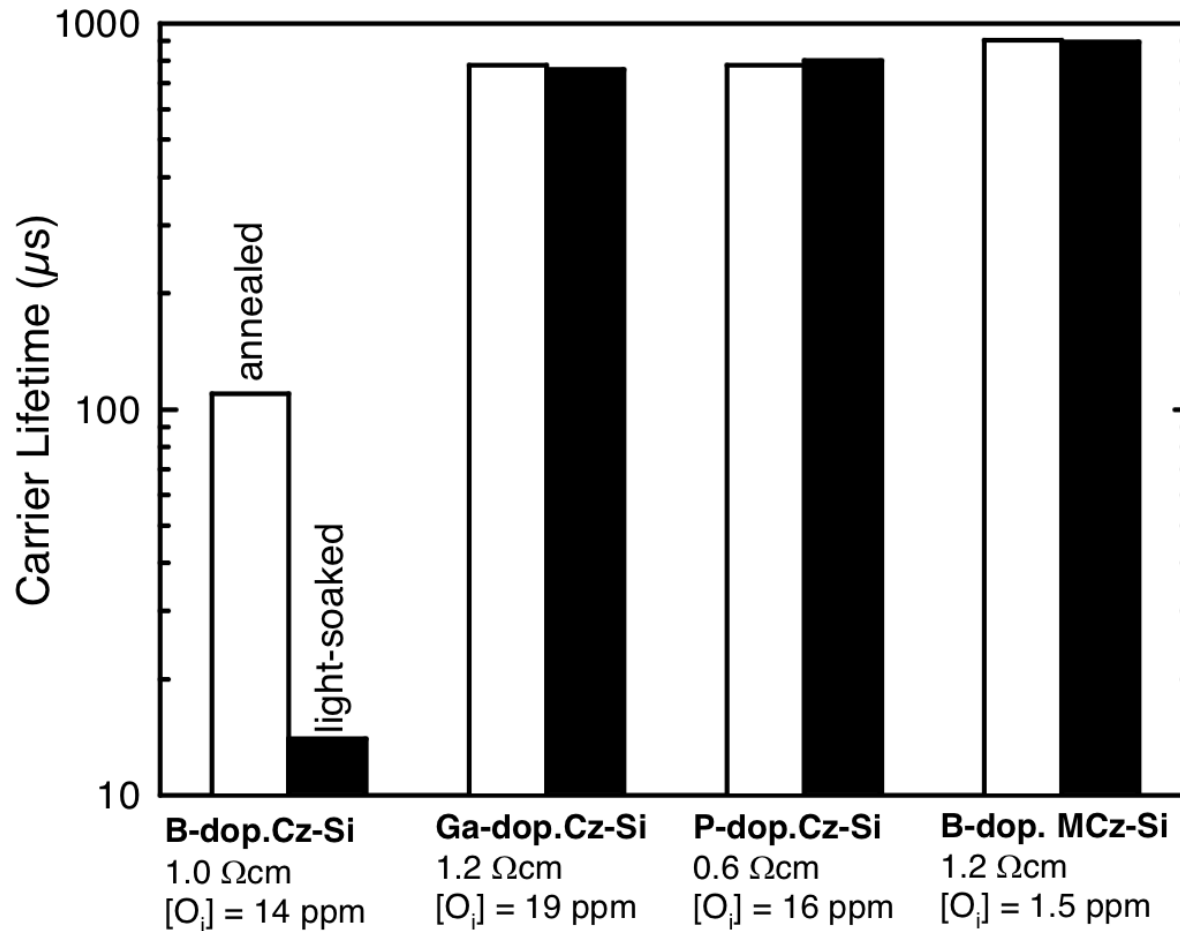
LID mechanism

- Formation of B_sO_{2i} due to illumination
- This defect introduces electronic states in the middle of the bandgap of silicon ($E_C - 0.4$)
- Results in lower minority carrier lifetime



Schmidt, Solid State Phenomena, vol. 95-96, pp. 187-196, 2004

LID mechanism



No degradation in Ga doped p-type Si and n-type silicon.

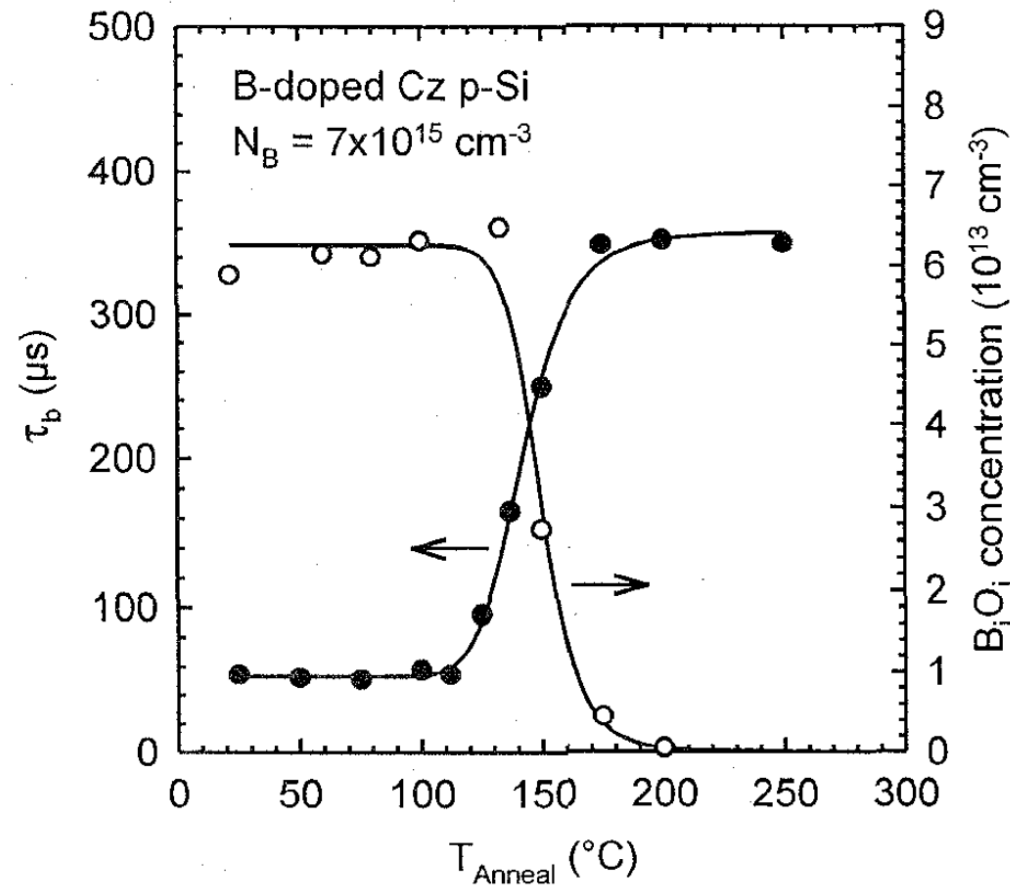
Schmidt, Solid State Phenomena, vol. 95-96, pp. 187-196, 2004

LID mechanism

Silicon type	Average LID of cell batches			
	Mean	Median	Min	Max
Mono	2,1%	1,8%	0,3%	5,1%
Multi	1,5%	1,4%	0,6%	3,5%
Multi UMG	4,0%	4,0%	1,9%	6,7%

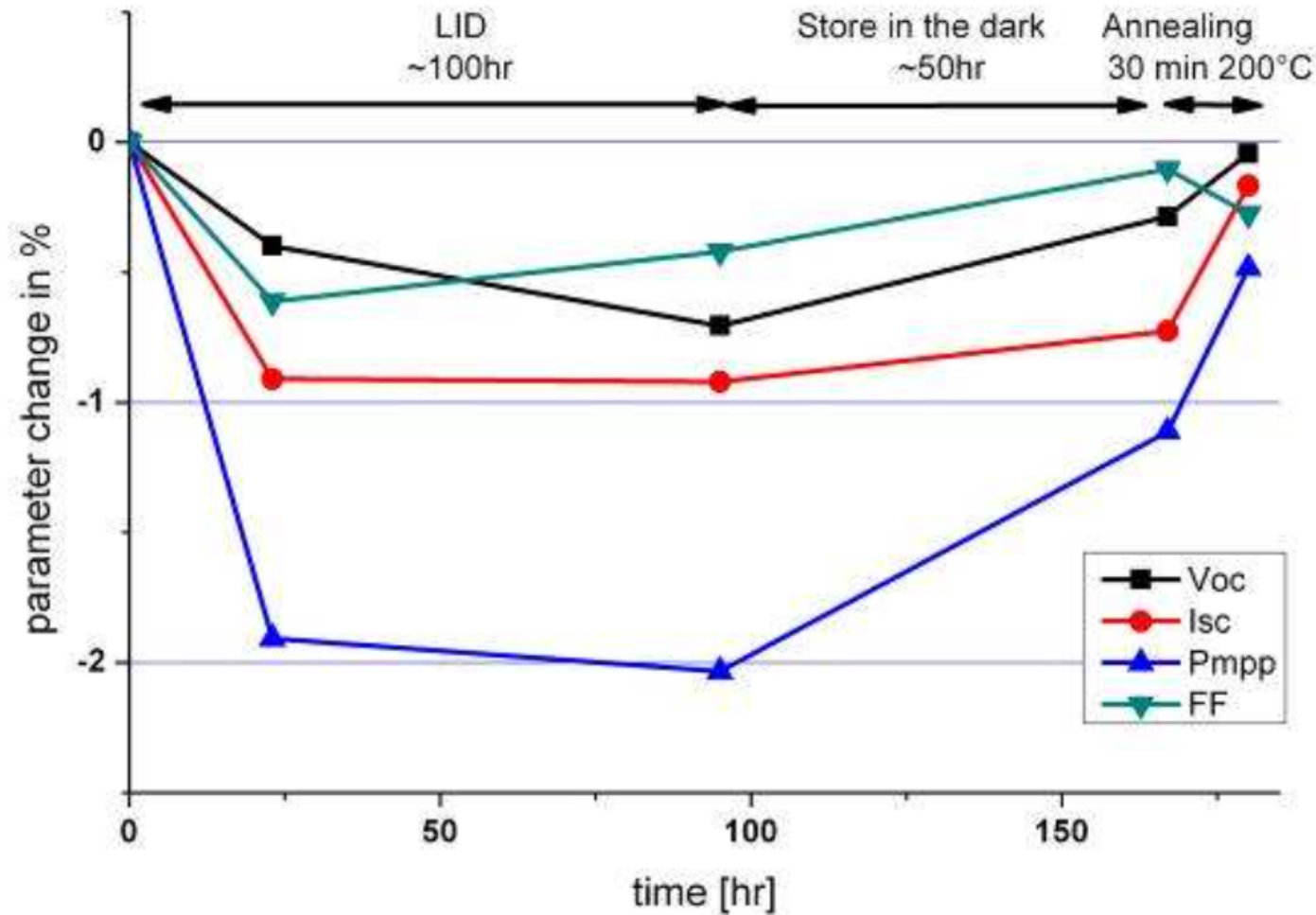
CZ mono wafers have higher concentration of oxygen than multi wafers.

Recovery of LID



Thermal annealing at 200 C or higher should recover the performance.

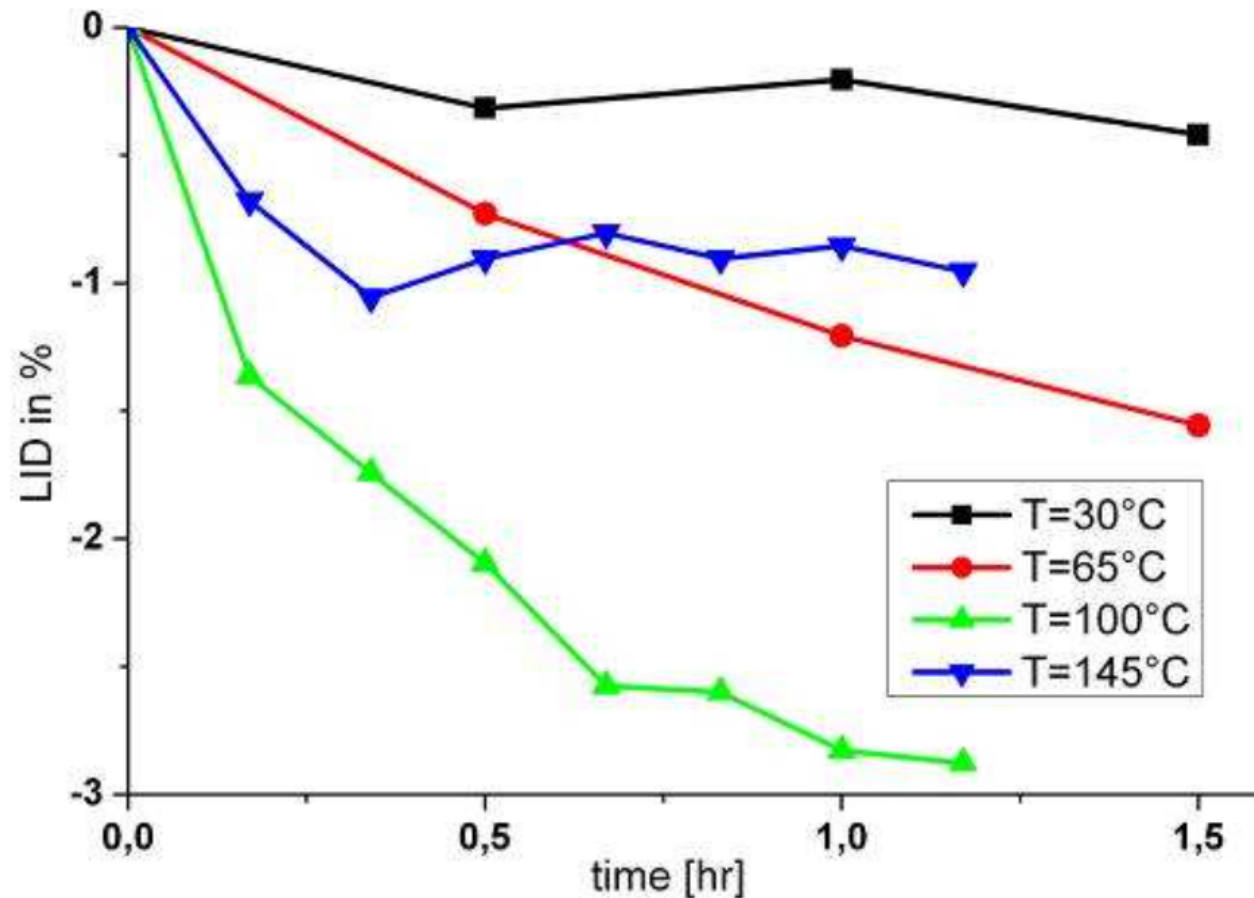
Recovery of LID (2)



LID – Mitigation Strategies

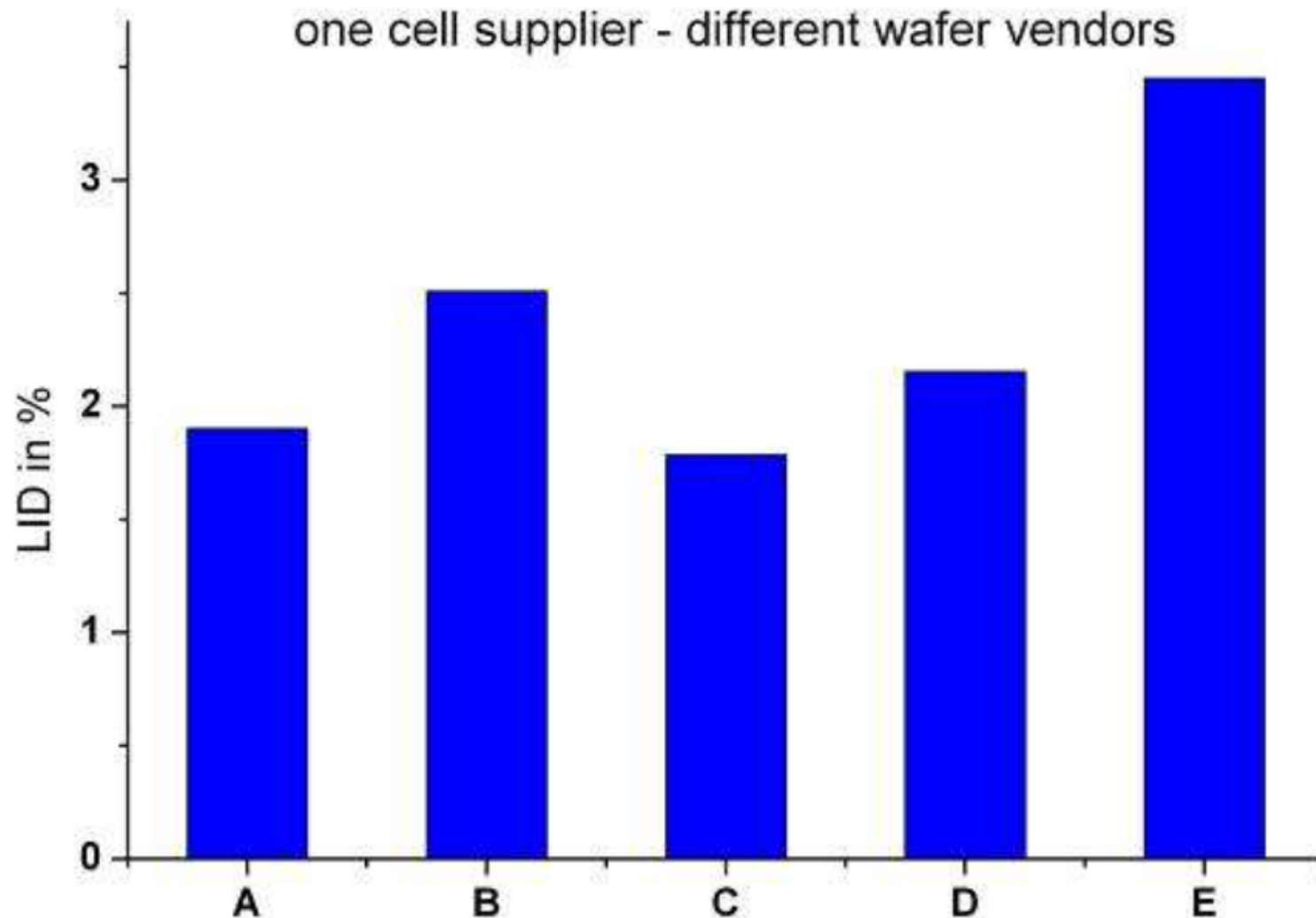
- Industry long term perspective
 - Move to n-type wafers
- Short term perspectives?
 - Quality checks
 - IEC 61215 specify light soaking but no temperature

LID – Mitigation Strategies: Points to ponder

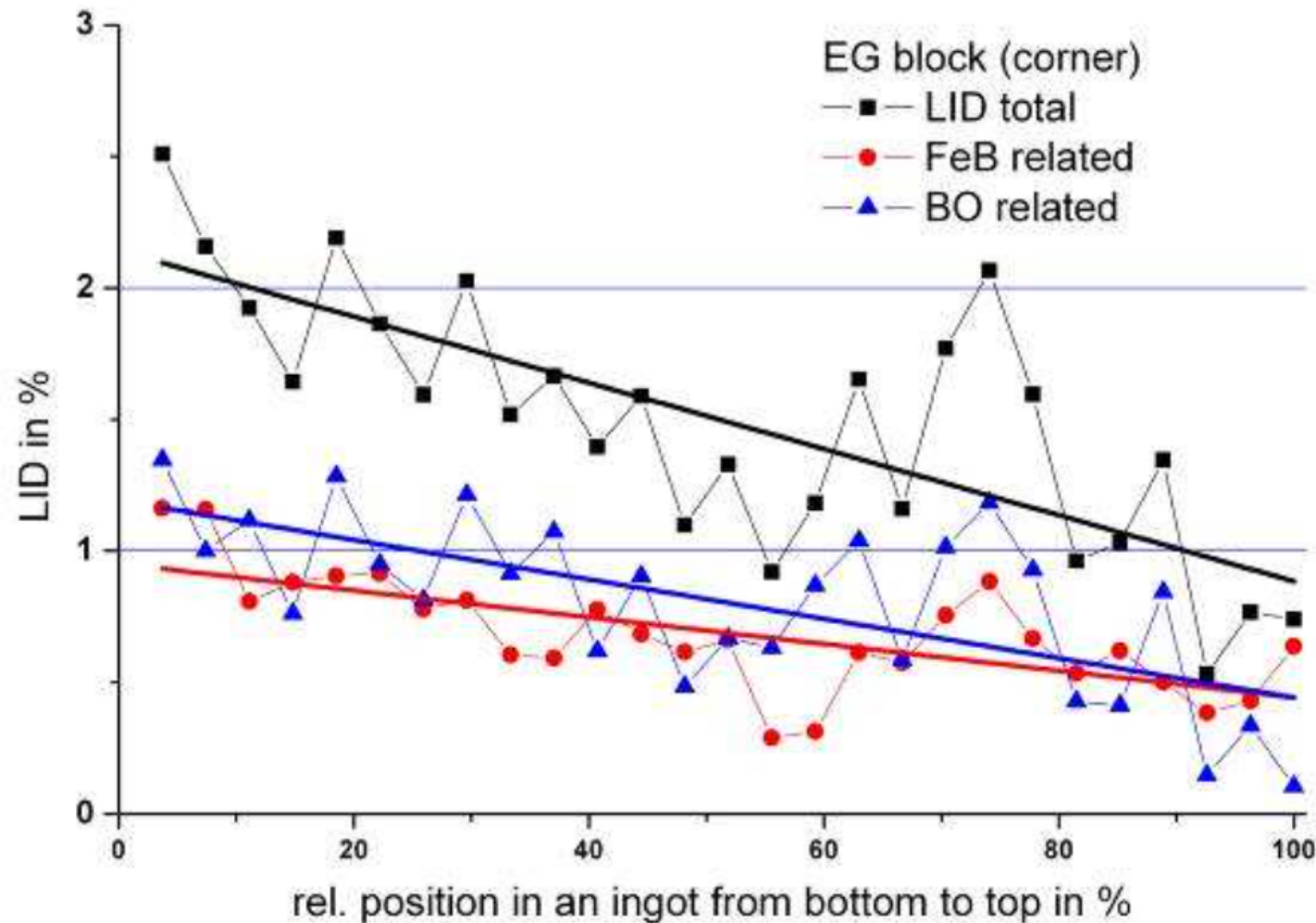


Temperature of light soaking should be specified.

LID – Mitigation Strategies: Points to ponder



LID – Mitigation Strategies: Points to ponder



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